



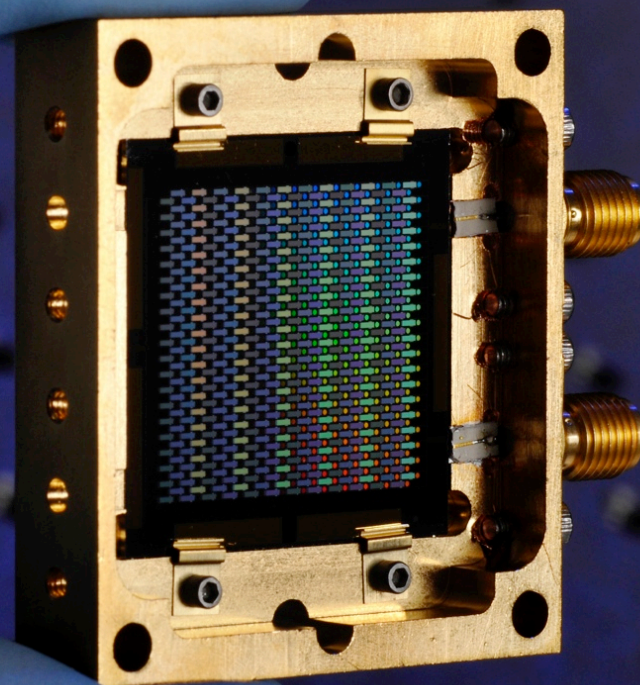
Development of TiN KID arrays for submm/far-IR astronomy



Caltech **JPL**

Jonas Zmuidzinas
+ CIT/JPL KID group

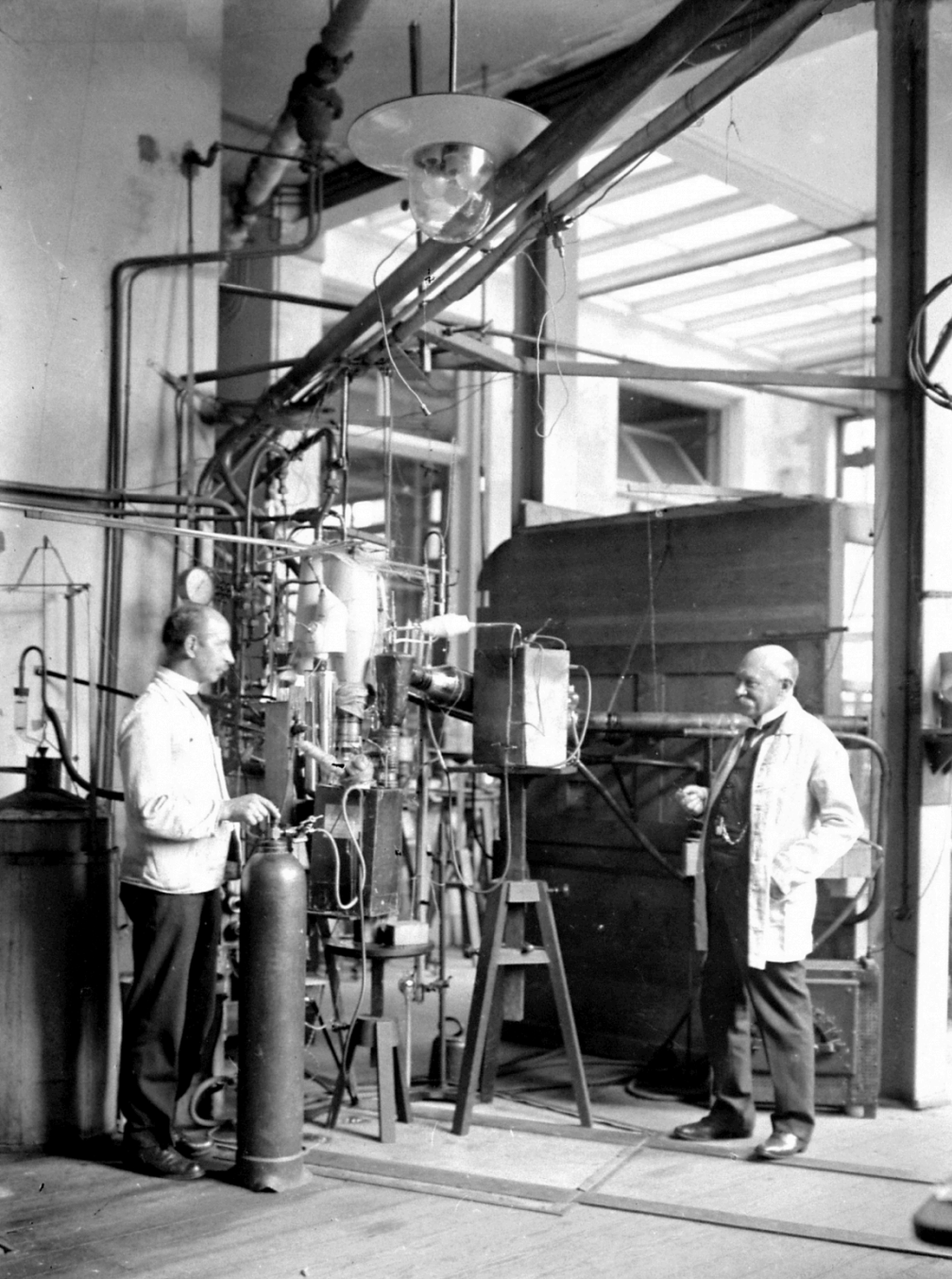
1999 – 2013: MKID (Microwave Kinetic Inductance Detector)



KID/MKID projects

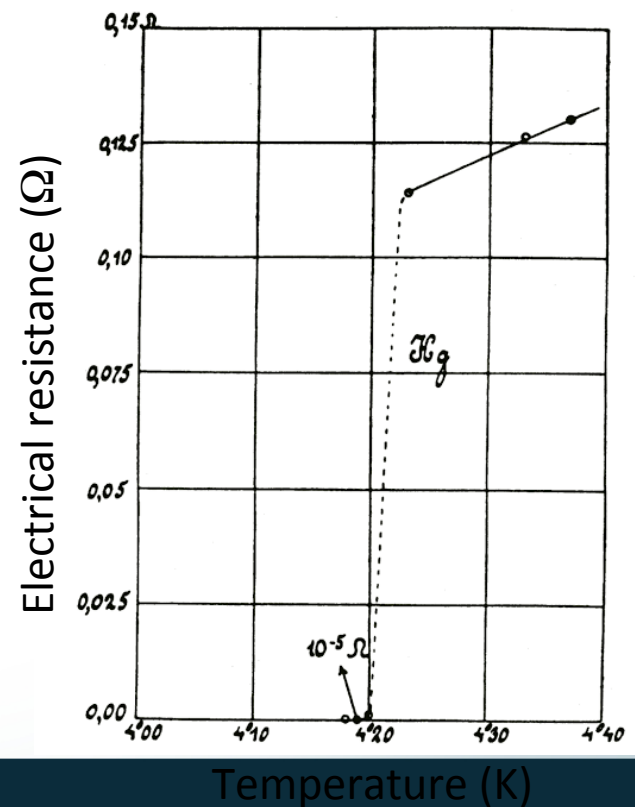


INSTITUTIONS	PROJECT	DESCRIPTION
MPIfR Bonn, SRON, TU Delft	A-MKID	20 kpixel submm camera for APEX (R. Gusten)
IRAM, Neel Institute, Cardiff	NIKA2	5 kpixel mm camera for IRAM 30m (A. Monfardini)
UCSB, JPL	ARCONS	2 kpixel optical camera for Palomar (B. Mazin)
Penn, NIST	BLAST upgrade	1000 pixel, dual-pol focal plane for balloon-borne far-IR polarimetry. PI: M. Devlin
Cardiff, SRON, TU Delft, Neel Institute Grenoble, Centro de Astrobiologia (Spain), AimValley, QMC Instruments	spaceKIDS http://www.spacekids.eu/	EU FP7 project. Development of MKID arrays for space applications. PI: Matt Griffin
Argonne National Lab	http://www.aps.anl.gov	Detectors for use with ALS synchrotron
Fermilab	http://www.fnal.gov	100 kpixel optical MKID camera for Dark Energy
NAOJ, U. Tokyo, U. Tsukuba, U. Saitama	http://atc.mtk.nao.ac.jp	CMB polarimetry: GroundBIRD, LITEBIRD
Columbia U.	SKIP http://arxiv.org/abs/1308.0235	Balloon-borne CMB polarimetry. PI: A. Miller
Penn, JPL	ICarIS	Balloon-borne far-IR spectroscopy. PI: J. Aguirre



Heike Kamerlingh Onnes
University of Leiden
1908: liquid helium
1911: superconductivity
1913: Nobel prize

$$R_{sc} < 10^{-16} \times R_{normal} ! \quad (1963)$$



Electrical Conductivity

$$\vec{F} = q\vec{E} - \frac{m}{\tau}\vec{v}$$

$$m\vec{a} = m \frac{d\vec{v}}{dt}$$

scattering time

$$\frac{d\vec{v}}{dt} + \frac{1}{\tau}\vec{v} = \frac{q}{m}\vec{E}$$

Newton's 2nd law

assume:

$$\vec{v}(t) = \text{Re} [\vec{v}_0 e^{j\omega t}]$$

$$\vec{E}(t) = \text{Re} [\vec{E}_0 e^{j\omega t}]$$

$$\left[j\omega + \frac{1}{\tau} \right] \vec{v}_0 e^{j\omega t} = \frac{q}{m} \vec{E}_0 e^{j\omega t}$$

$$\vec{J} = nq\vec{v}$$

Current density

$$\vec{J}_0 = \left[\frac{nq^2\tau}{m} \right] \left[\frac{1}{1 + j\omega\tau} \right] \vec{E}_0$$

$$\vec{J} = \sigma \vec{E}$$

Ohm's law – definition of σ

$$\sigma(\omega) = \frac{\sigma(0)}{1 + j\omega\tau}$$

Conductivity

$$\sigma(\omega) = \frac{nq^2}{m} \frac{1}{j\omega}$$

Superconductor:
 $\tau \rightarrow \infty$

Two-fluid model

“superconducting electrons”:

$$\sigma_{sc}(\omega) = \frac{nq^2}{m} \frac{1}{j\omega}$$

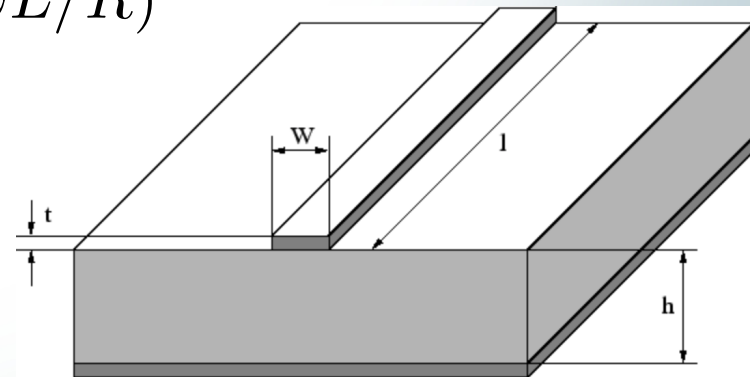
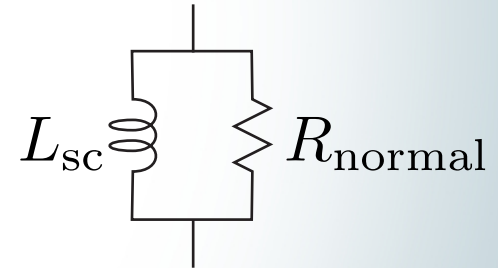
“normal electrons”:

$$\sigma_{normal}(\omega) = \frac{\sigma(0)}{1 + j\omega\tau_{normal}} \approx \sigma(0)$$

Superconducting + normal:

$$\sigma_{total} = \sigma_{sc} + \sigma_{normal}$$

$$\begin{aligned} Z(\omega) &= \frac{1}{\sigma_{total}(\omega)} \frac{l}{wt} = \frac{1}{\frac{1}{R} + \frac{1}{j\omega L}} \\ &= \frac{j\omega L}{1 + j\omega L/R} \approx j\omega L (1 - j\omega L/R) \\ &= + \frac{\omega^2 L^2}{R} + j\omega L \end{aligned}$$



Note : $Z(\omega) \rightarrow 0$ as $\omega \rightarrow 0$

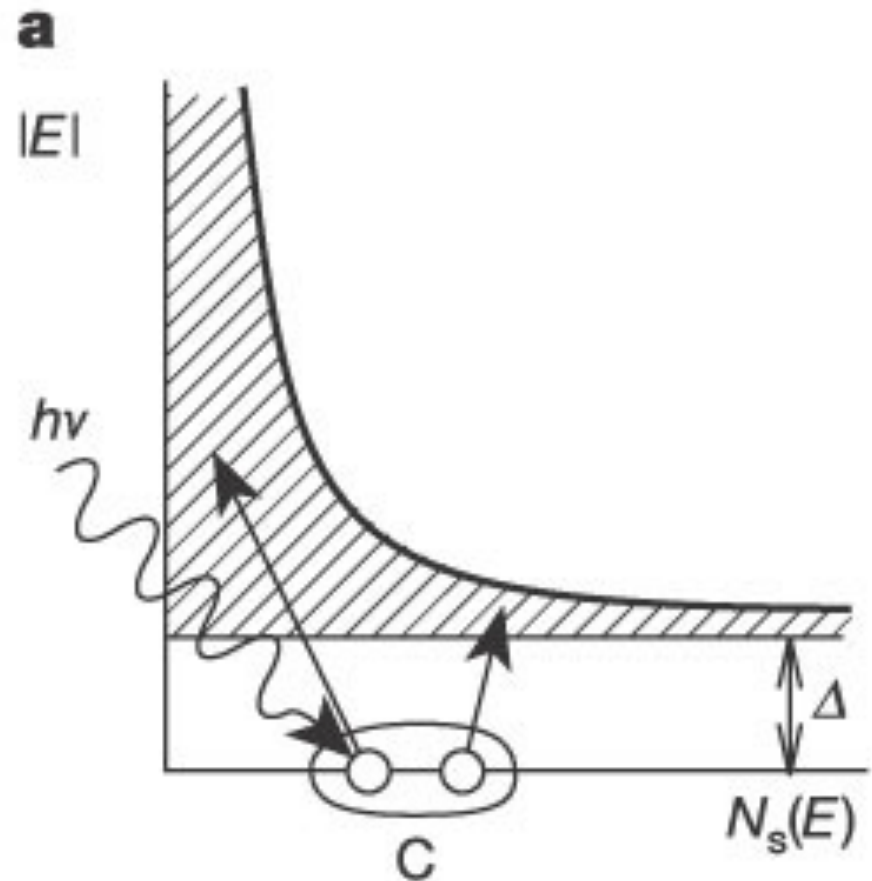
Pair breaking by photons

Pair breaking occurs when:

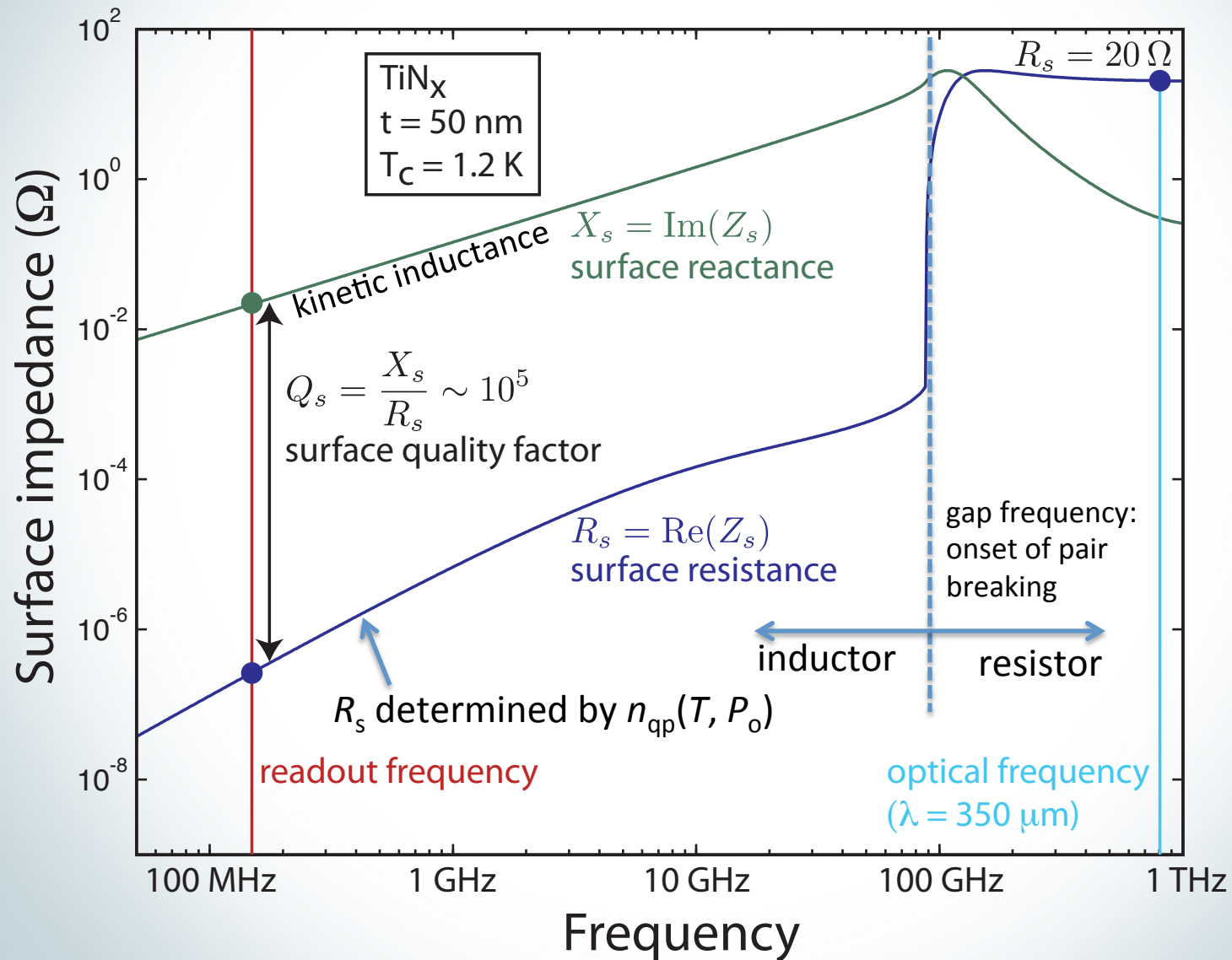
$$h\nu = \hbar\omega > E_{\text{gap}} = 2\Delta$$

Pair breaking does not occur at microwave frequencies

Pair breaking does occur at far-IR/IR/visible frequencies



Impedance vs Frequency

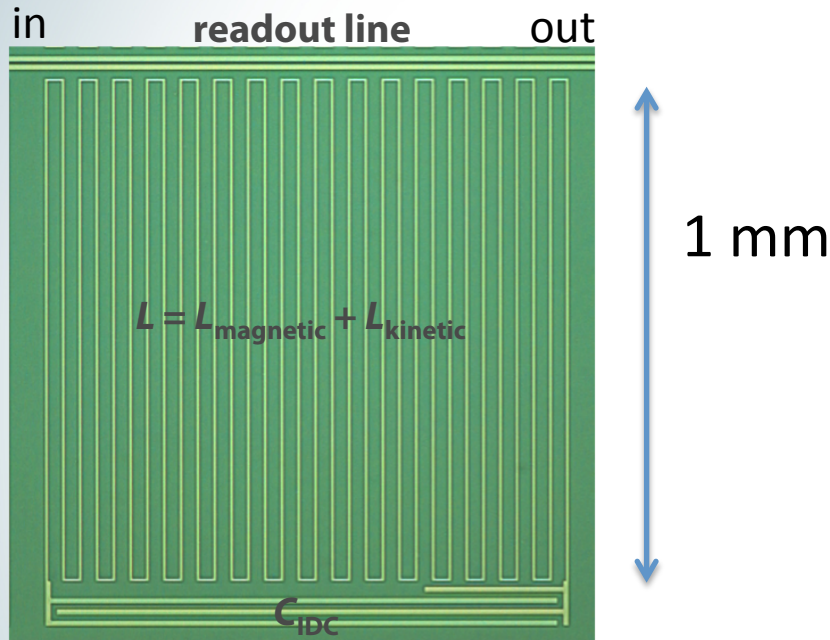


Microwave Kinetic Inductance Detector (MKID)



Cardiff "LEKID" pixel

TiN film (gold) on Si substrate (green)

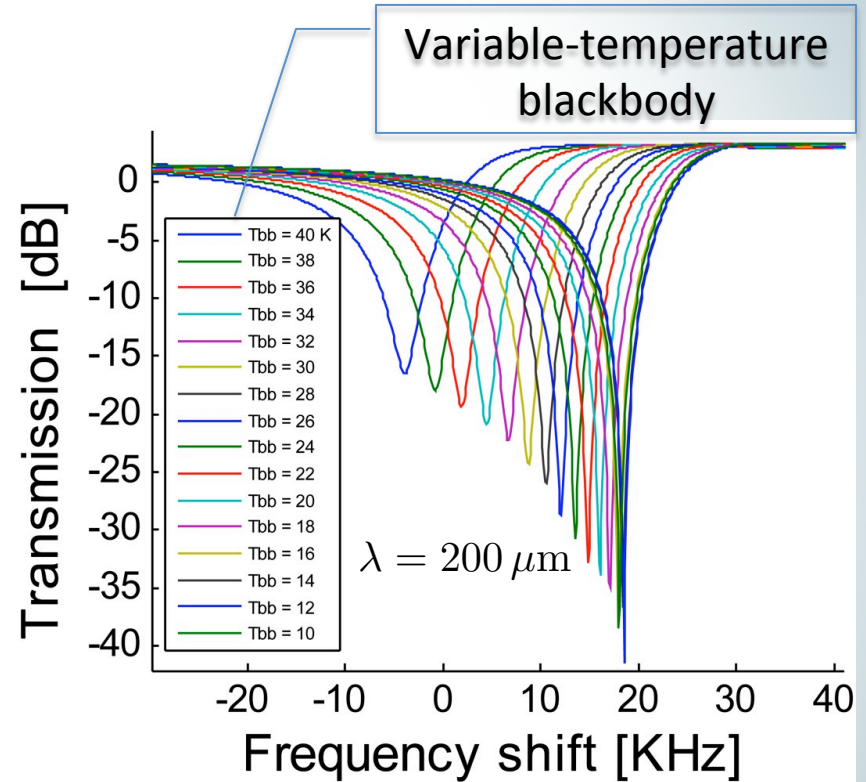


Inductor (L) + capacitor (C) = RF resonator

$$\nu_r = \frac{\omega_r}{2\pi} = \frac{1}{2\pi\sqrt{LC}} \approx 1 \text{ GHz}$$

TiN inductor is also the optical absorber

- High resistivity: $\rho_{\text{TiN}} \sim 500 \rho_{\text{Al}}$ (at 10 K)
- High absorption efficiency
- TiN absorber used in Herschel/PACS bolometers

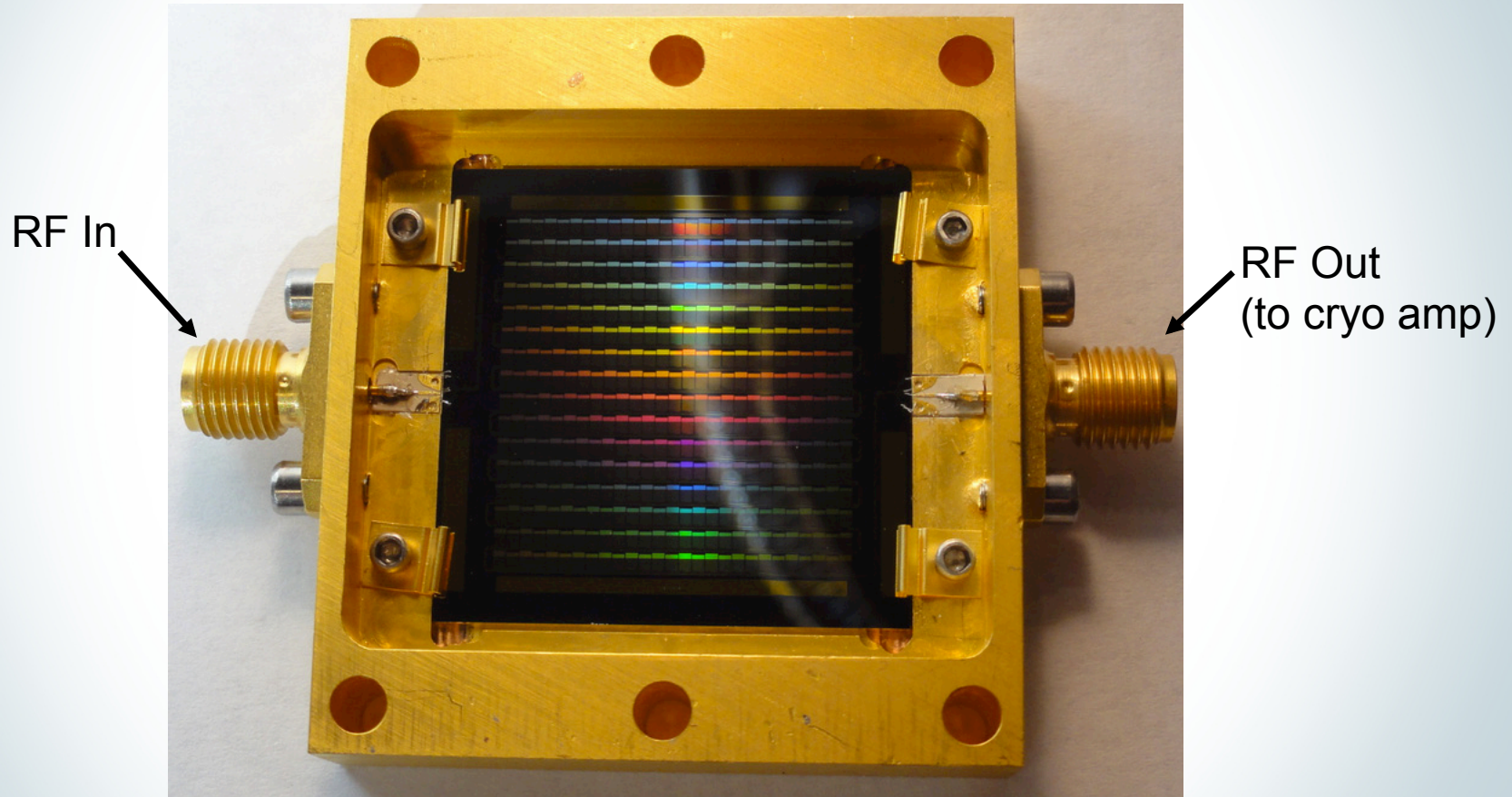


Resonator frequency shifts down as submm radiation is applied

$$\delta x = \frac{\delta \nu_r}{\nu_r} = \frac{1}{2} \frac{\delta L_{\text{kinetic}}}{L} \sim \frac{10 \text{ kHz}}{1 \text{ GHz}} = 10^{-5}$$

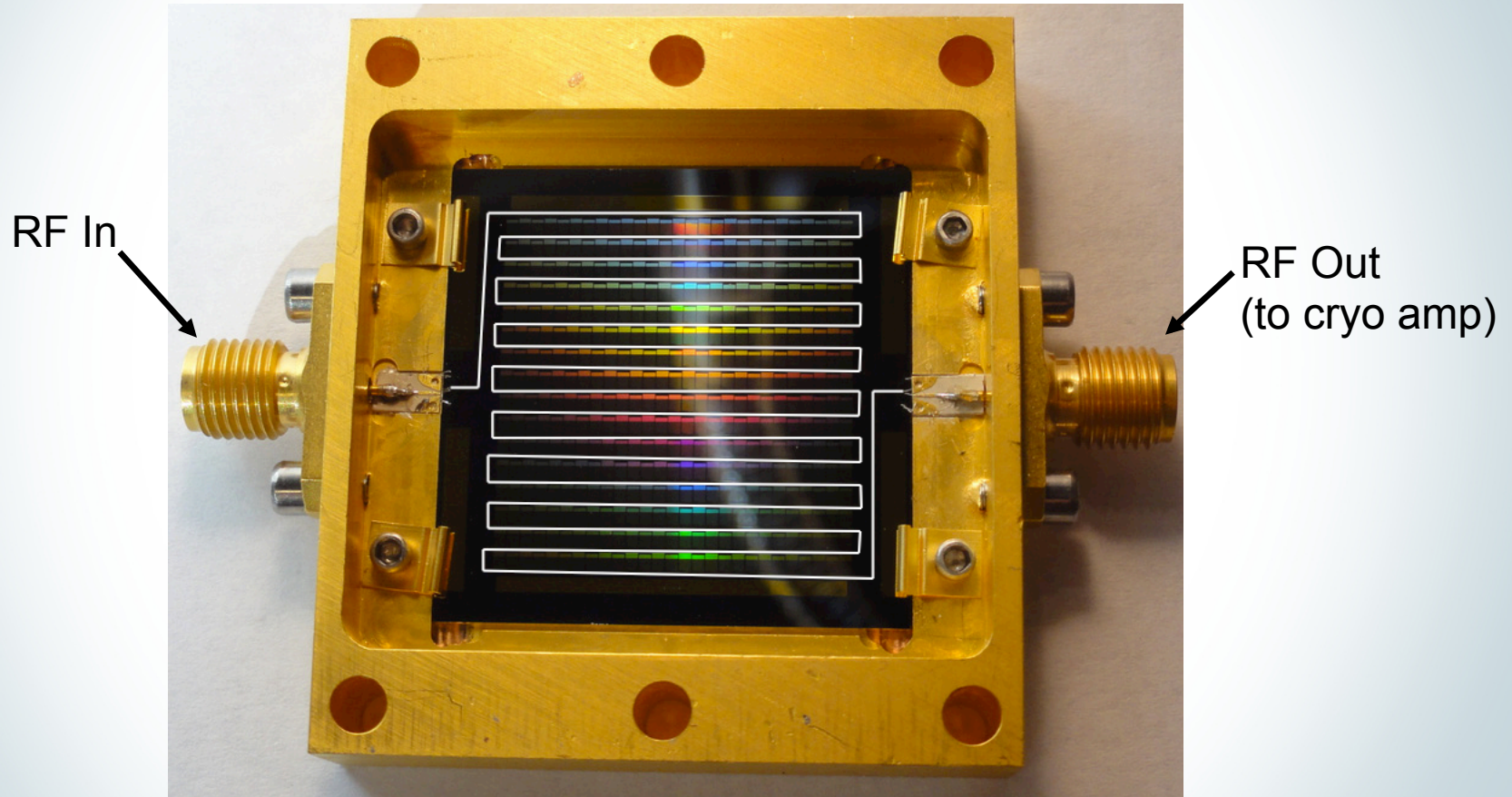
MKID = Microwave Kinetic Inductance Detector

Frequency multiplexing (18 x 24 = 432 pixels)



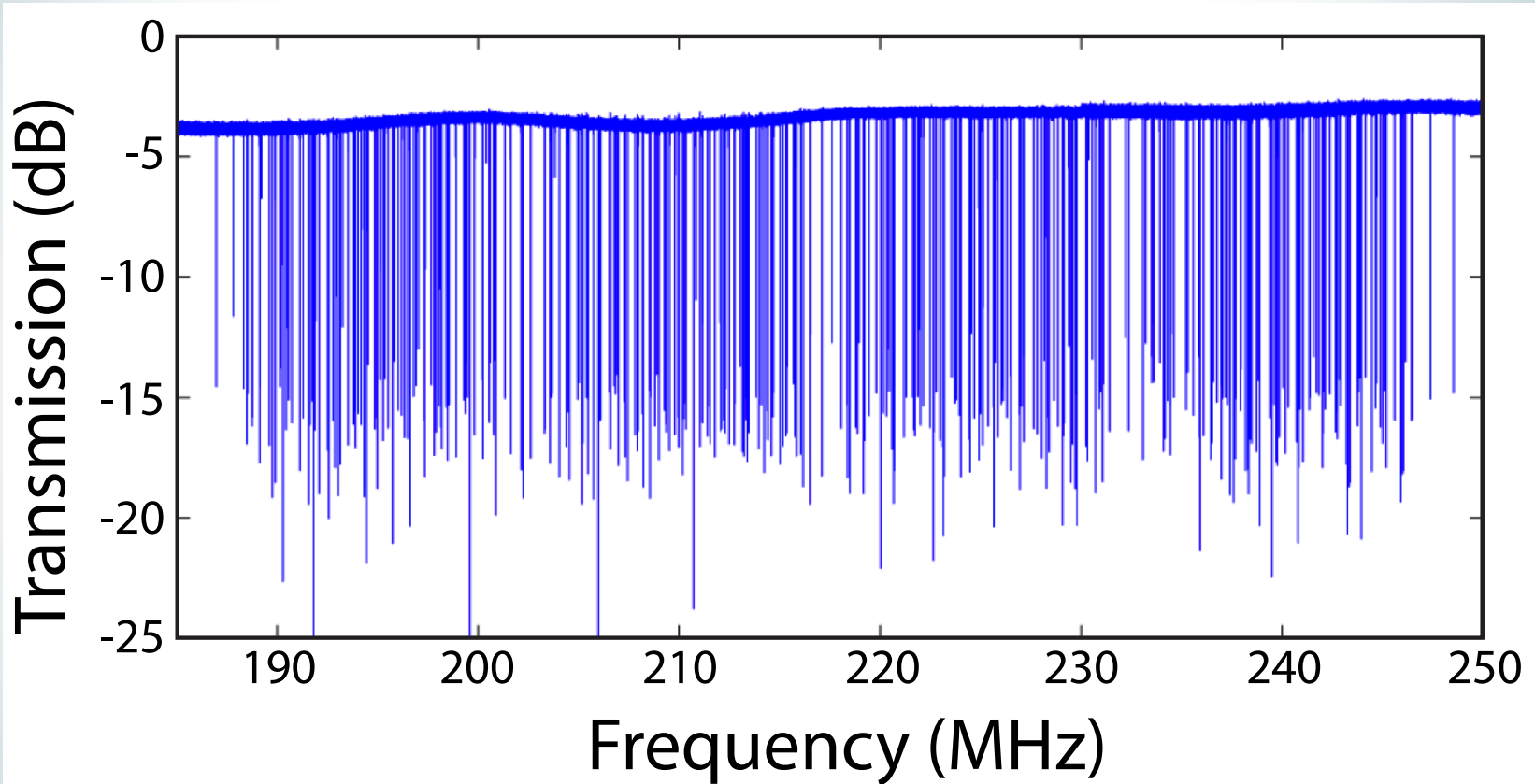
Fabrication - Rick Leduc at JPL

Frequency multiplexing ($18 \times 24 = 432$ pixels)



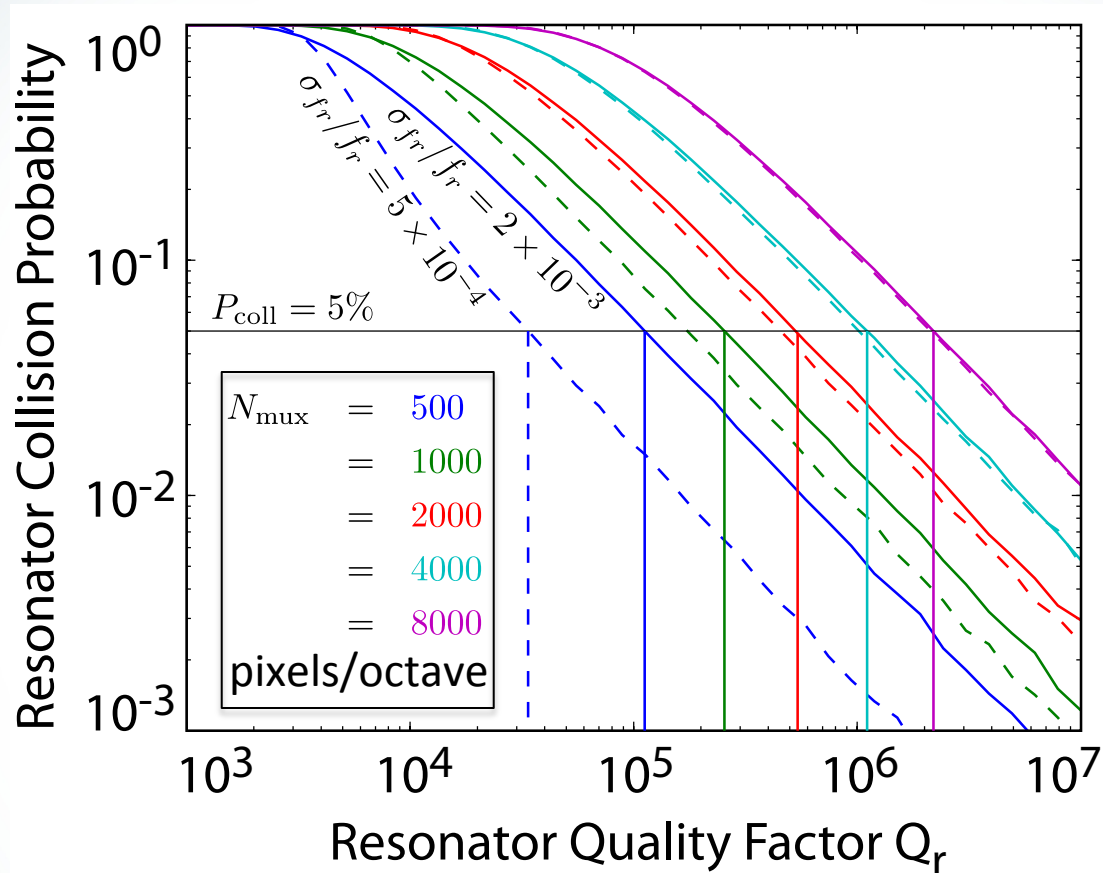
Fabrication - Rick Leduc at JPL

Frequency sweep



- **Low readout frequency** (200 MHz) enabled by use of TiN (large $\rho_n \rightarrow$ large L_k)
- Resonator frequencies span 185-250 MHz (65 MHz bandwidth or 0.43 octaves)
- 415/432 resonators deeper than 6 dB (96% yield)
- 160 kHz average spacing

Resonator Q sets mux density

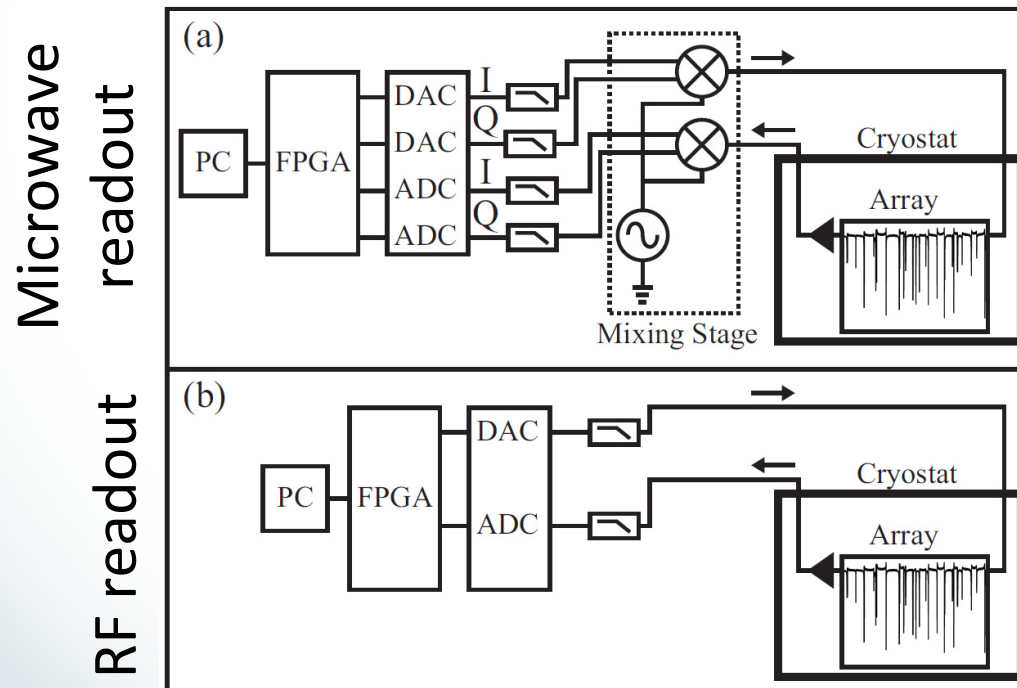


$$\frac{1}{Q_r} = \frac{1}{Q_c} + \frac{1}{Q_i}$$

- High $Q_r \rightarrow$ low collision probability
 - Do not rely on precise placement of resonator frequencies (σ_f)
 - Collision probability independent of σ_f for high mux density
- Need $Q_r \sim 10^5$ to multiplex 500-1000 pixels/octave
- Previous slide: 432 pixels / 0.43 octave = 994 pixels/octave @ 96% yield

Multichannel Digital Readout

- FPGA implements digital channelizer for readout tone separation
- Microwave (GHz) readout requires up/down frequency conversion
- RF readout (< 500 MHz) allows “direct drive” with ADC/DAC
 - Reduces readout bandwidth, complexity, and cost
 - Converters are typically 12-bit, 500 MSPS (ADC < \$200 ea)
 - **Use frequency readout** since $\beta = \delta x / \delta Q^{-1} \sim 50 \ (\propto 1/\omega_r)$



L. Swenson, LTD-15 2013



CIT/JPL Development Timeline

- 1987: kinetic inductance bolometer proposed (McDonald/NIST)
 - SQUID readout
- 1999: “modern” KIDs proposed (Zmuidzinas & Leduc)
 - Microresonator as pair-breaking detector, $T \ll T_c$ operation, vector RF/microwave readout, cryogenic transistor LNA, frequency multiplexing
- 2003: lab demo of x-ray detection (Day *et al.*, Nature)
 - Excess noise measured, origin not understood
- 2008: excess noise produced by resonator capacitor
 - due to surface layer of TLS fluctuators (Gao *et al.*, APL)
- 2010: TiN introduced, high Q demonstrated (Leduc *et al.*, APL)
 - High resistivity \rightarrow THz LEKID absorber, high KI fraction, 100-200 MHz readout
- 2012: interpixel EM coupling and its cure (Noroozian *et al.*, IEEE MTT)
- 2013: operation into deep nonlinear KI regime (Swenson *et al.* JAP)
- 2013: 432-pixel, 350 μm MAKO camera demonstrated on CSO (April)
 - CCAT PDR (September)
- 2014: NbTiN resonator bolometer demonstrated (Swenson *et al.*, in prep.)



Sensitivity

- Determined by responsivity R_x and noise S_x
 - Noise equivalent power (NEP)

$$\text{NEP}(\nu) = \frac{\sqrt{S_x(\nu)}}{R_x(\nu)} \quad \text{W Hz}^{-1/2}$$

- Fractional frequency responsivity

$$R_x = \frac{dx}{dP_o} \quad \text{W}^{-1} \quad (\text{rolls off due to } \tau_{qp}, \tau_r)$$

- Fractional frequency noise power spectral density

$$S_x(\nu) = \text{PSD}_x(\nu) = \langle |\text{FFT}[\delta x(t)]|^2 \rangle \quad \text{Hz}^{-1} \quad (\sigma_x^2 \text{ in 1 Hz BW around } \nu)$$

- Detector NEP should be below photon NEP
 - Increase responsivity and/or reduce noise

Responsivity model

- Optical power produces quasiparticles:

$$\delta N_{\text{qp}} = \frac{\eta_o \delta P_o}{\Delta} \tau_{\text{qp}} \quad \tau_{\text{qp}} \text{ depends on material, } T_c, \text{ optical load...}$$

- Quasiparticles cause frequency shift:

$$\delta x = \frac{\delta f_r}{f_r} = \frac{1}{2} \frac{\delta L_{\text{kinetic}}}{L} = \frac{1}{2} \frac{L_{\text{kinetic}}}{L} \frac{\delta L_{\text{kinetic}}}{L_{\text{kinetic}}} \sim \frac{1}{2} \alpha \frac{\delta N_{\text{qp}}}{2N_0 \Delta V_L}$$

kinetic inductance fraction

- Responsivity is given by:

$$\mathcal{R}_x = \frac{dx}{dP_o} = \frac{\alpha \gamma S_2 \eta_o \tau_{\text{qp}}}{4N_0 \Delta^2 V_L} \quad \alpha \gamma S_2 \eta_o \sim 0.5 - 1$$

single-spin electron density of states

- **Rely on measurements of R_x**

- Adjust N_0 to match measurements

Optical to qp energy conversion efficiency

- Methods to boost responsivity:

- reduce T_c (smaller Δ , larger τ_{qp})
- reduce inductor volume V_L (smaller absorber \rightarrow microlenses)
- (recycle phonon energy - place inductor on thermal island)
 - effectively increases τ_{qp}

Noise model

- Random fluctuations of quasiparticle population

- Photon arrivals

$$\text{NEP}_{\text{photon}}^2 = 2P_o h\nu (1 + n_o)$$

- qp recombination

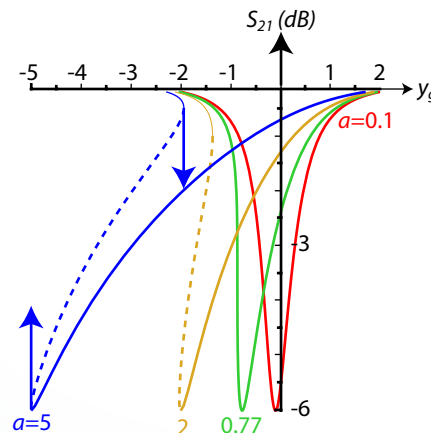
$$\text{NEP}_{g-r}^2 = \frac{4\Gamma_{\text{th}}\Delta^2}{\eta_o^2} + \frac{2N_{\text{qp}}\Delta^2}{\eta_o^2} (\tau_{\text{max}}^{-1} + \tau_{\text{qp}}^{-1})$$

- Readout noise

- Dominated by first-stage cryo amplifier

$$S_x^{\text{amp}} = \frac{kT_{\text{amp}}}{P_g} \frac{Q_c^2}{4Q_r^4}$$

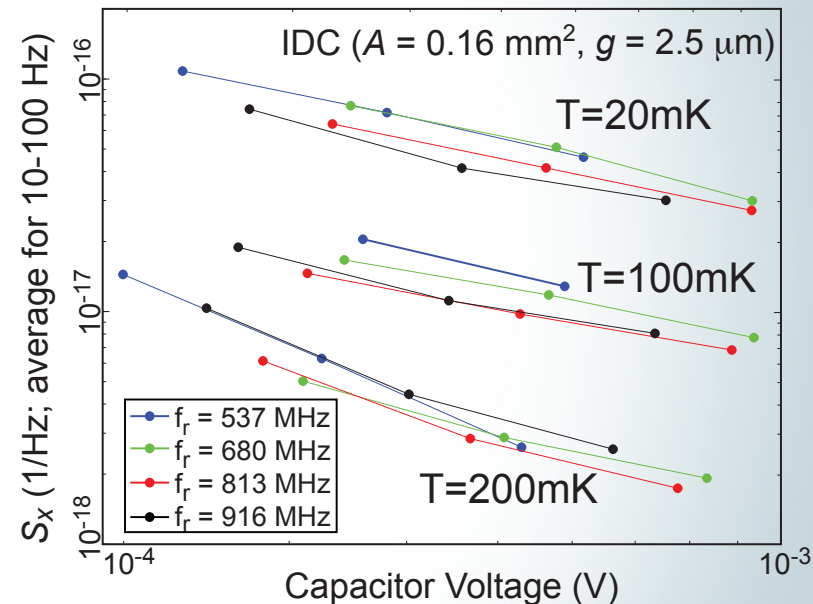
- For simplicity, keep generator power P_g below bifurcation



Swenson et al 2013

- Capacitor noise

$$S_x = \text{PSD}(\delta C/2C)$$



Array Design Details



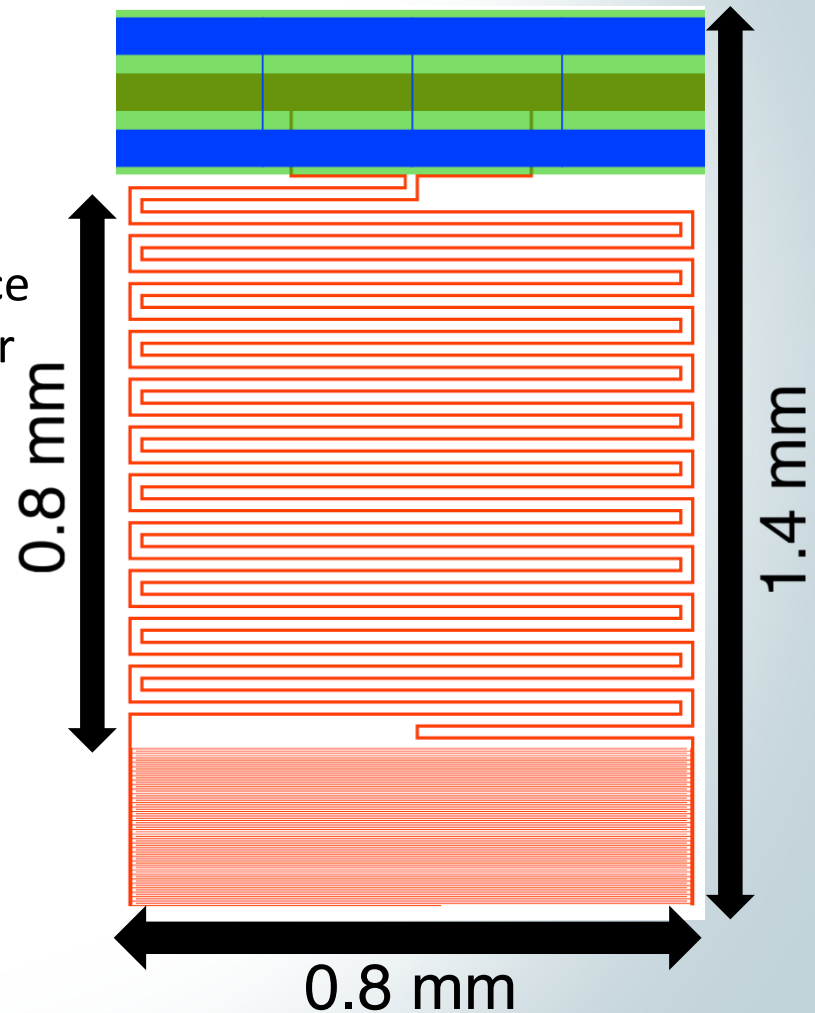
Ver	Layout	Opt. Couple	Inductor				Capacitor		Freq	Lith Steps	Pixels	Pol.
			Area	Trace	Sep	t	Area	Sep				
			mm ²	μm	μm	nm	mm ²	μm	MHz			
1G	Square	Bare	0.64	4	8	50	<0.4	2	170-240	3	432	1
2G	Hex 1mm ²	μLens (F/2)	0.3	2	4	50	0.6	2-6	200-240	2	488	1
3G	Hex 1mm ²	μLens (F/2)	0.3	1	9	100	0.6	4-9	100-150	2	488	2

- 1G: Tested at CSO (MAKO)
- 2G: Currently lab testing
- 3G: Design phase

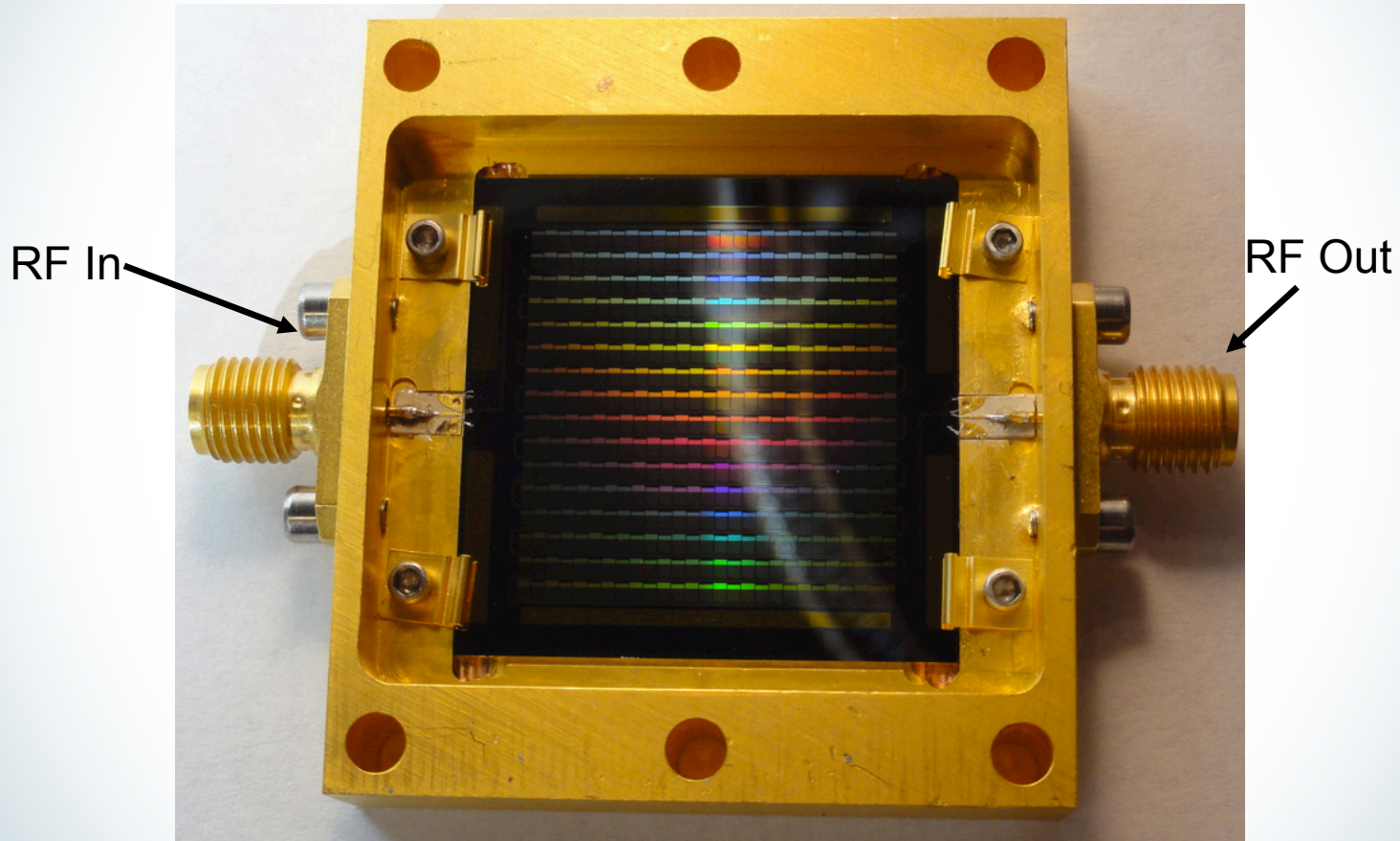
350 μm Pixel Design (TiN 1G)



- CSO/MAKO demonstration
- LEKID pixel style (Doyle et al 2007)
 - F# and λ set absorber size:
 - $F\lambda / 2 \sim 0.8 \text{ mm}$
 - Matching of absorber to wave impedance in silicon (90Ω) determines TiN fill factor and volume of inductor/absorber
 - Capacitor area: trade-off between readout frequency & capacitor noise vs focal plane filling efficiency
 - 432 pixels fills one stepper field
 - Allows rapid iteration



TiN 1G: 432-pixel array

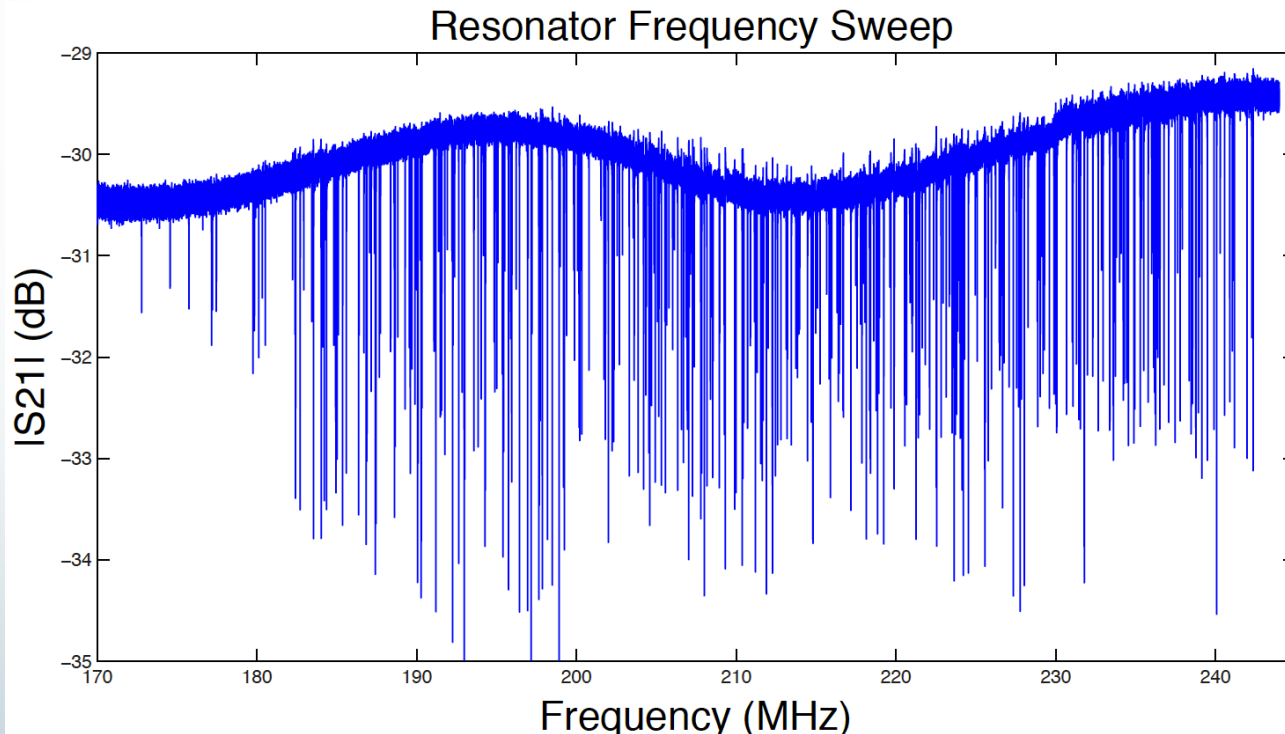


Fabrication - Rick Leduc at JPL

TiN 1G - frequency sweep

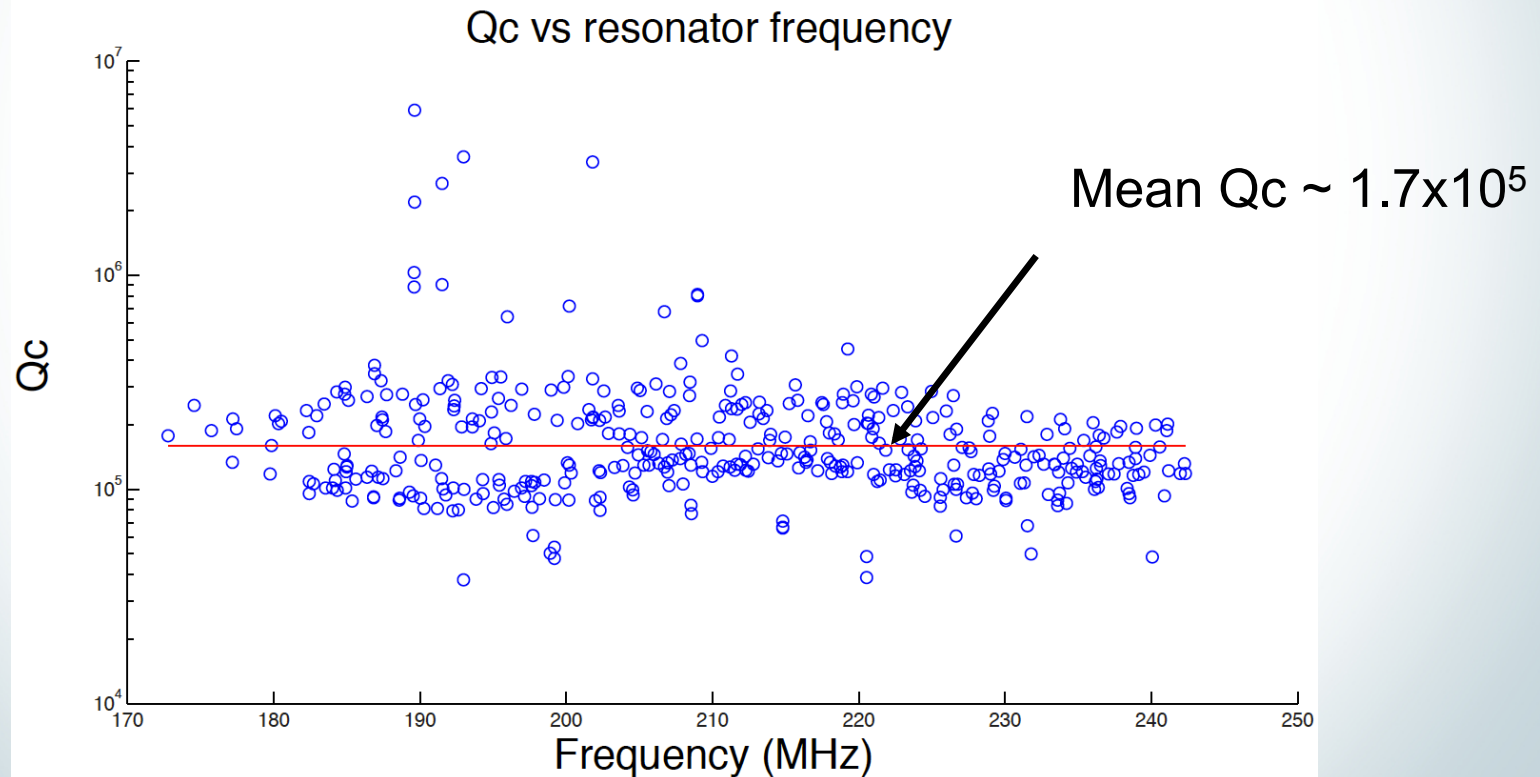


- Measurements results were promising:
 - MUX density: ~ 500 pixels/half octave
 - High yield ($> 95\%$ visible, $>90\%$ with usable spacing)
 - Uniform coupling and low ripple on transmission line



TiN 1G – Coupling Q

- Very uniform coupling Q
 - Design value: 2×10^5

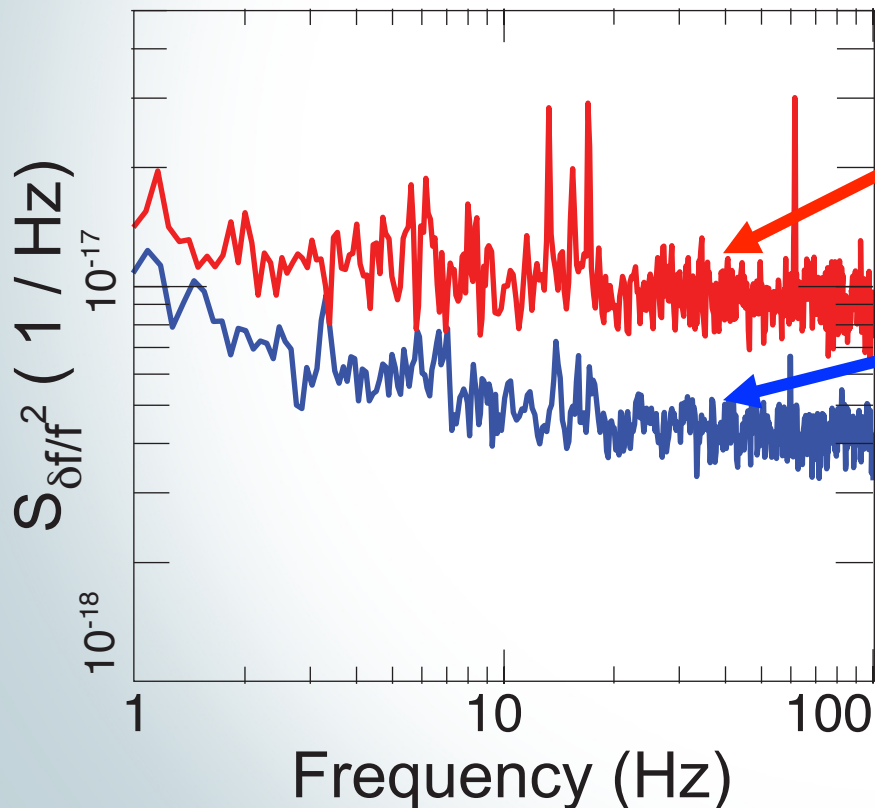


TiN 1G: Lab Noise Measurement



- Mounted in dilution refrigerator

– Cold blackbody, filters at $212 \mu\text{m}$ $\frac{h\nu}{k_B} = 68 \text{ K}$



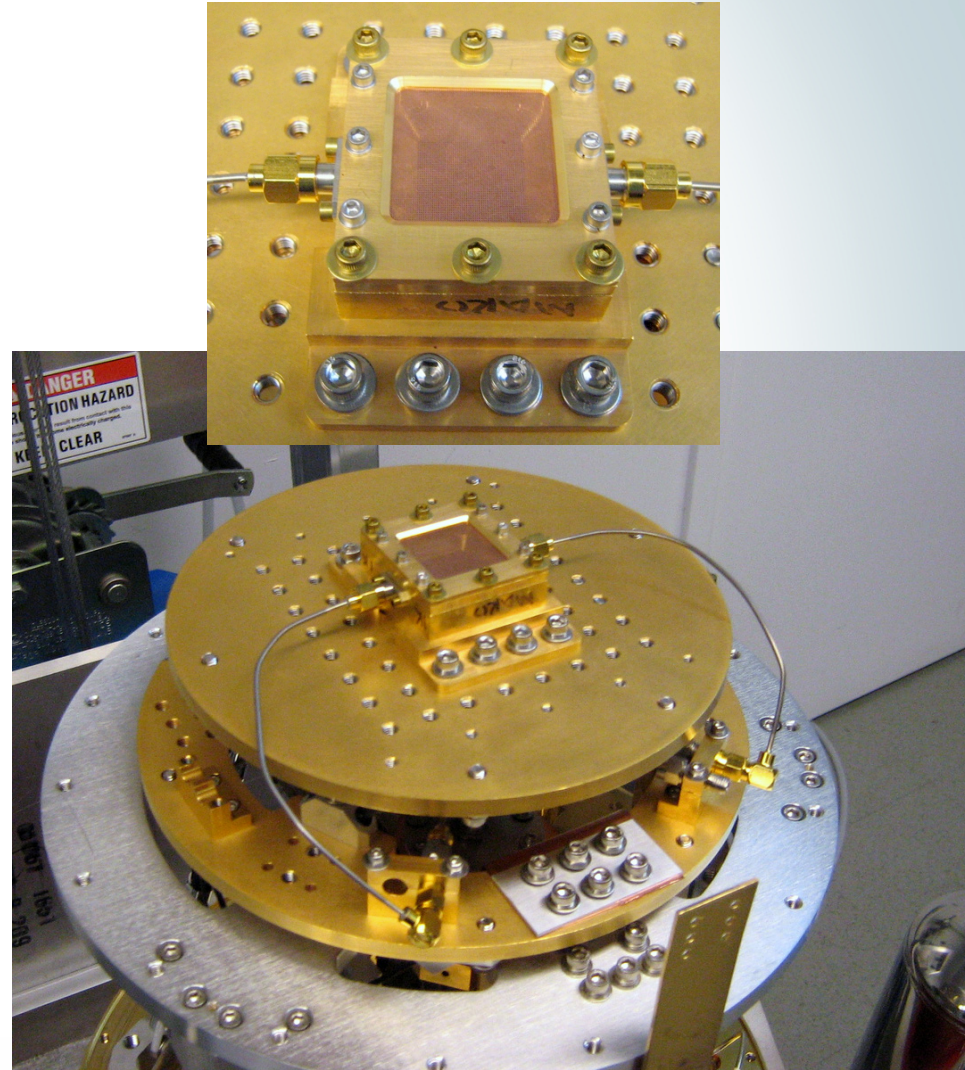
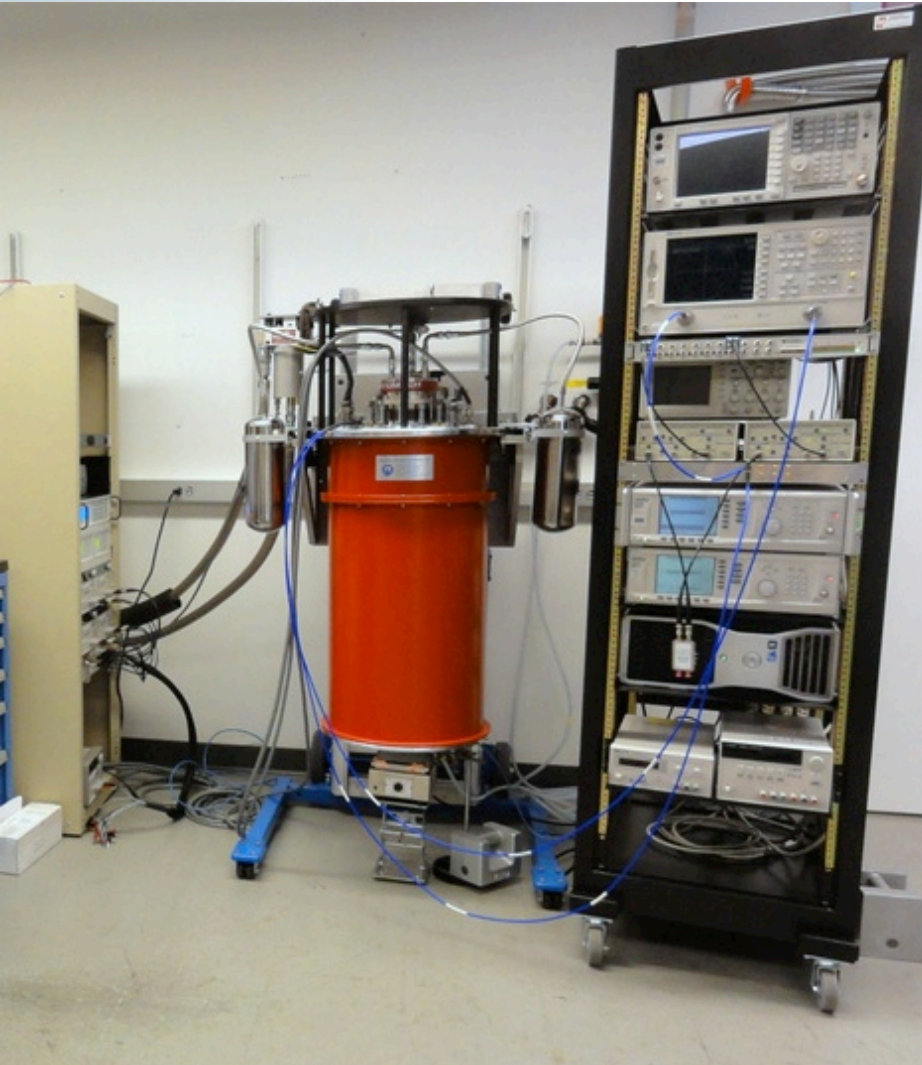
$T_{\text{BB}} = 35 \text{ K}, P_{\text{inc}} \sim 120 \text{ pW}$

$T_{\text{BB}} = 25 \text{ K}, P_{\text{inc}} \sim 50 \text{ pW}$

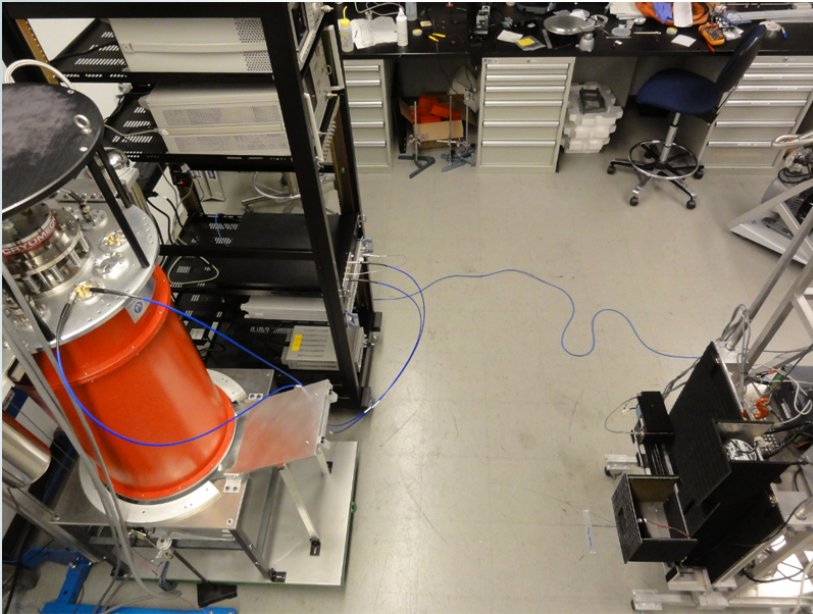
- Photon noise visible to a few Hz
- Optical efficiency ~ 0.7
- Capacitor noise dominates below 1 Hz
- Loading higher than CSO
- Predict $\sim 2\text{-}3\text{x}$ photon NEP at CSO (for single polarization)

MAKO: a prototype camera

(Swenson et al, SPIE Proc., 2012)



MAKO In Lab



MAKO In lab:

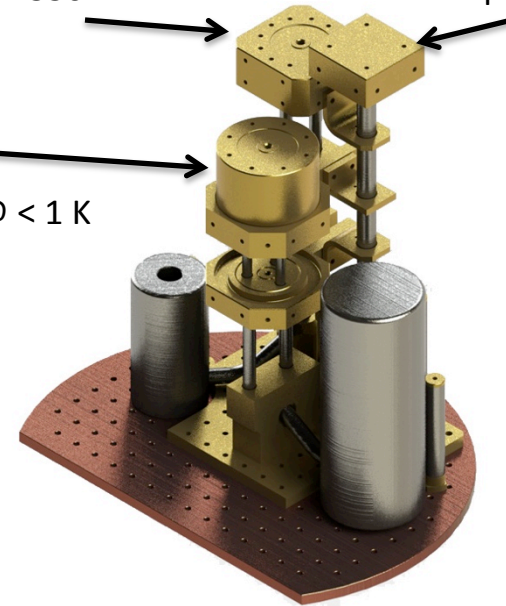
- Mounted on optics to mimic SHARC-II
- ROACH board + clock on electronics rack
- Beam mapper placed at focus to test point source response

Cryostat cold head

^3He buffer head
30 μW @ < 350 mK

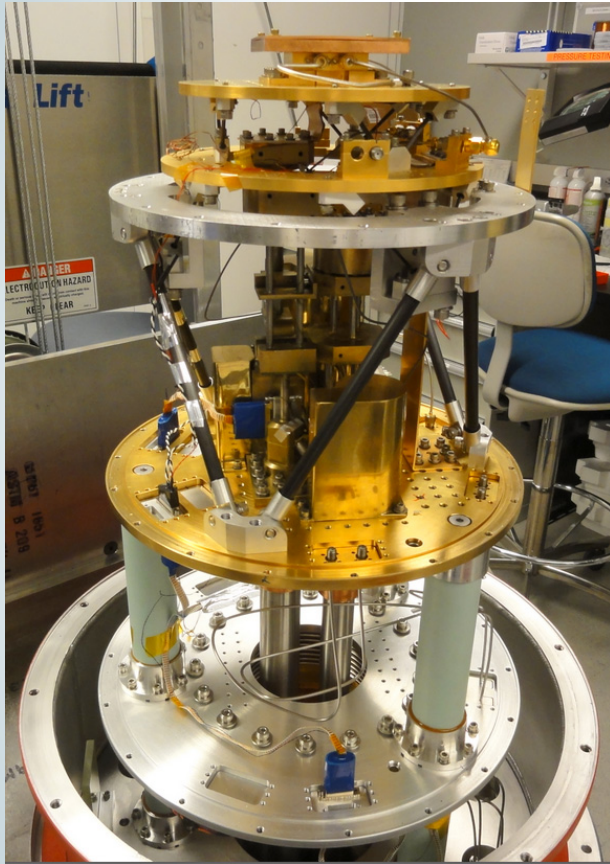
^3He head
1 μW @ < 220 mK

1 K head
250 μW @ < 1 K



- Cryostat by Precision Cryogenics
- PT410 Pulse tube cooler
- ^3He system
 - base T 240mK under loading
 - hold time \sim 36 hours

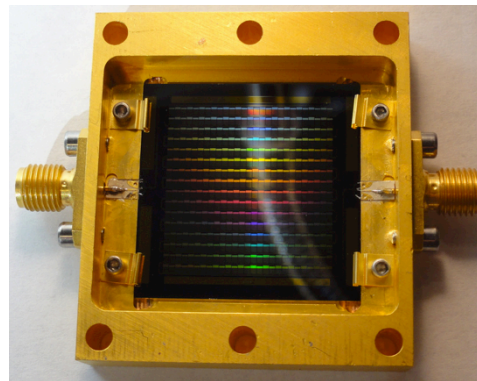
MAKO Optics



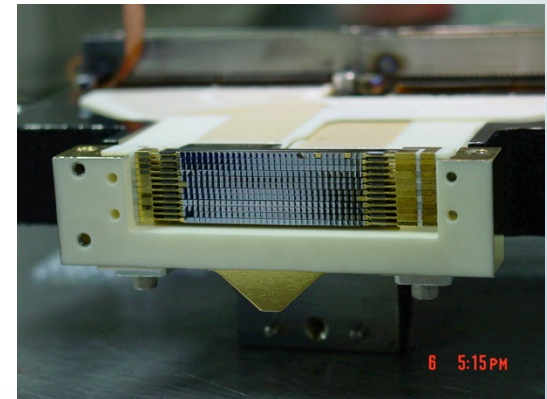
MAKO cryostat: optics designed to closely match CSO's SHARC-II camera

	Absorber Size	# Pixels	Polarizations	Backshort?
	(mm ²)	(nominal)		
SHARC-II	1 x 1	384	2	yes
Mako	0.8 x 0.8	432	1	no

- *A SHARC-II pixel receives 4.4x more optical power compared to a MAKO pixel*



MAKO detector array (multiplexed)



SHARC-II detector array (individually wired)

MAKO goes to the CSO

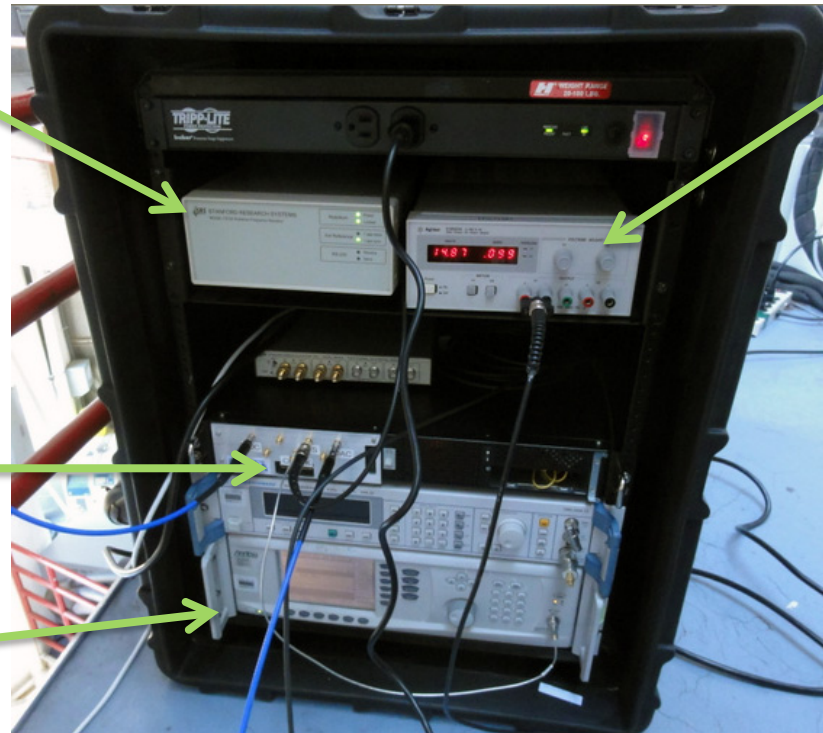


MAKO goes to the CSO



10 MHz rubidium standard & 1 PPS Signal
(from GPS antenna)

Amp
Bias



ROACH

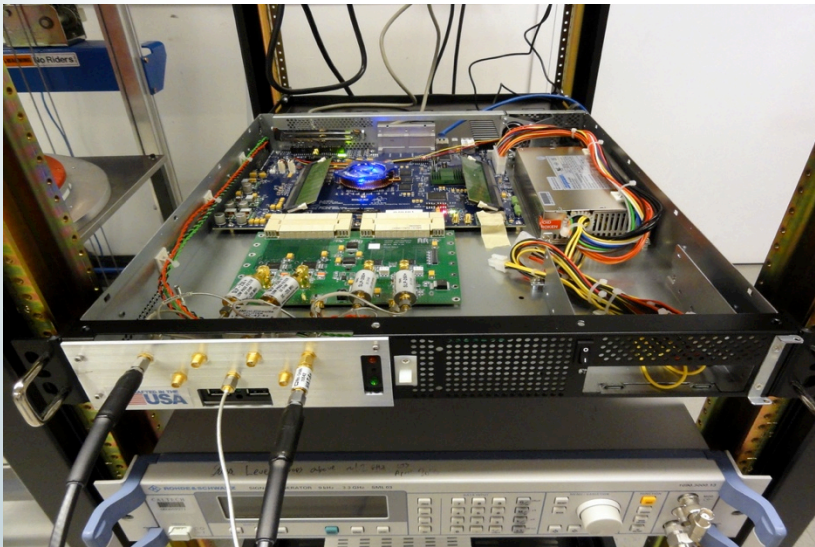
Roach Clock
(500 MSPS)

10 MHz standard, Clock, and Amp bias can be shared by multiple ROACH readouts

MAKO Readout Electronics



- ROACH Readout
 - Open-source FPGA readout (CASPER/Berkeley)
 - Adopted existing hardware to meet observing date
 - Maximum readout frequency: 250 MHz
 - 500 MSPS ADC converters operating in 1st Nyquist zone

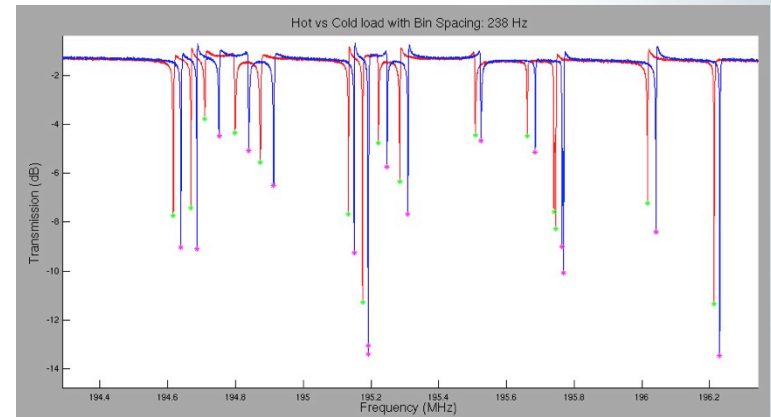
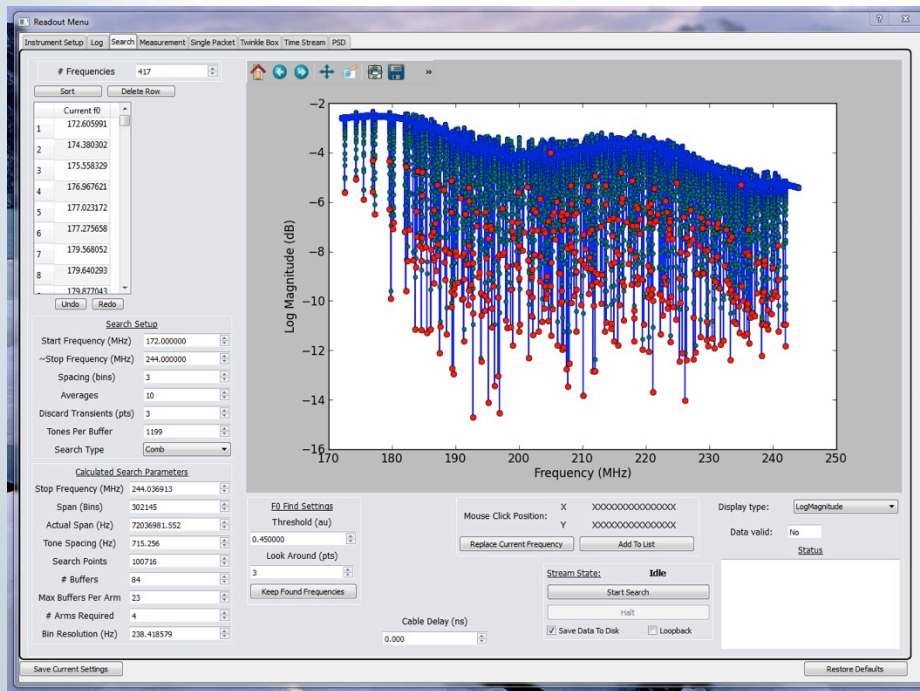


- MAKO implemented with ~ 500 pixels with one ADC and one DAC
- FPGA firmware supports up to 4k pixels per ROACH
- FPGA firmware developed by R. Monroe/JPL

MAKO goes to the CSO



- Front end software:
 - Calibration and measurement of IQ streams
 - Found > 95% of designed pixels



300 K vs **77 K** load

Readout interface and visualization software developed by L. Swenson

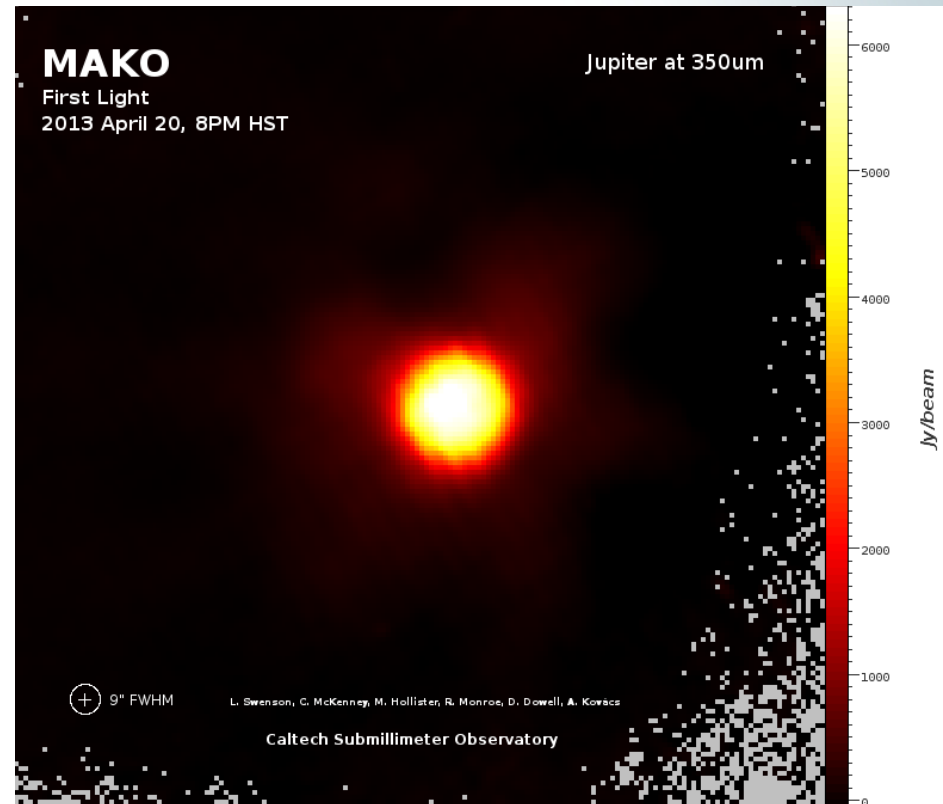
MAKO goes to the CSO



- First Light on the first night of observing!



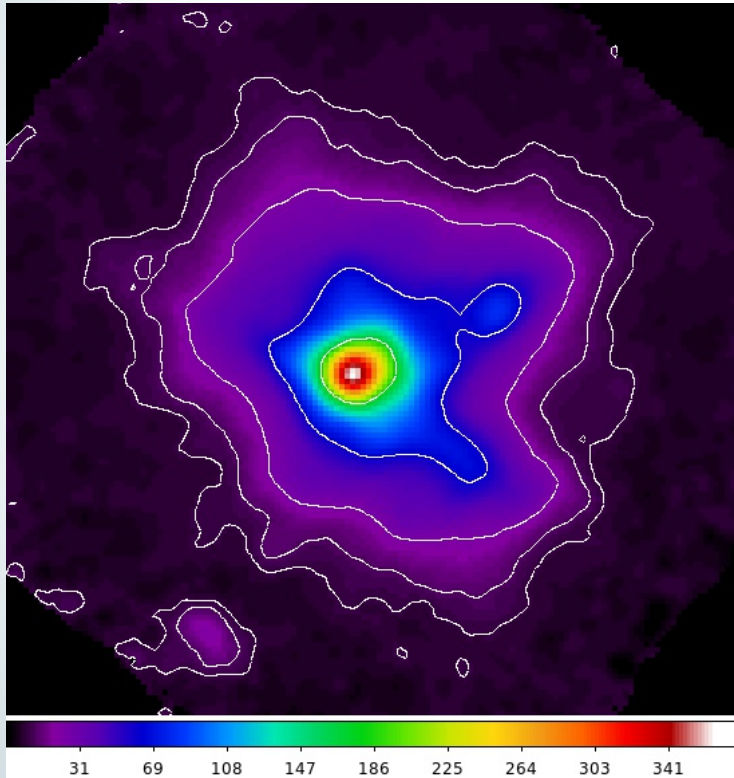
Photo by L. Swenson



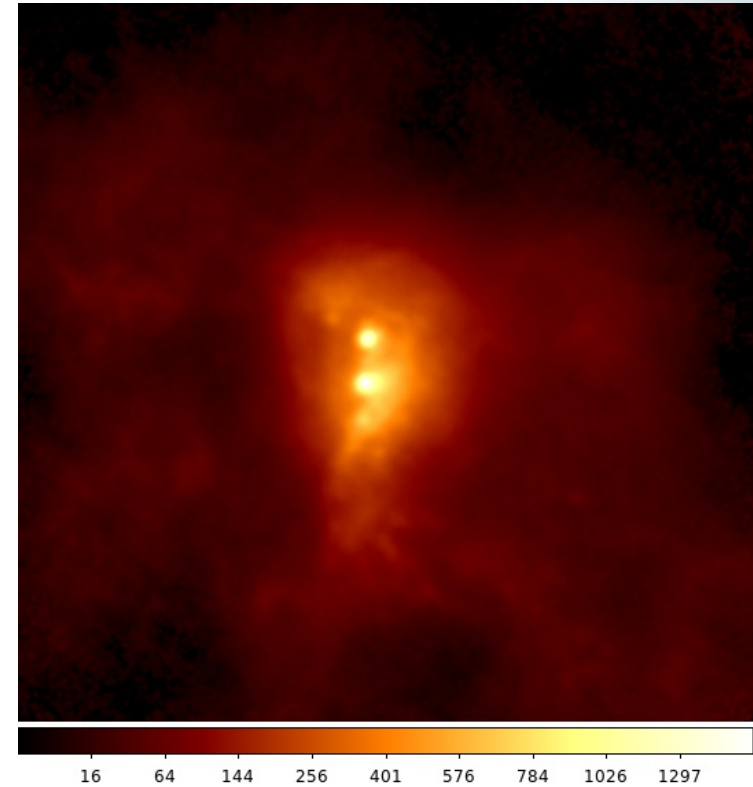
MAKO goes to the CSO



- Some decent weather nights:



G34.3

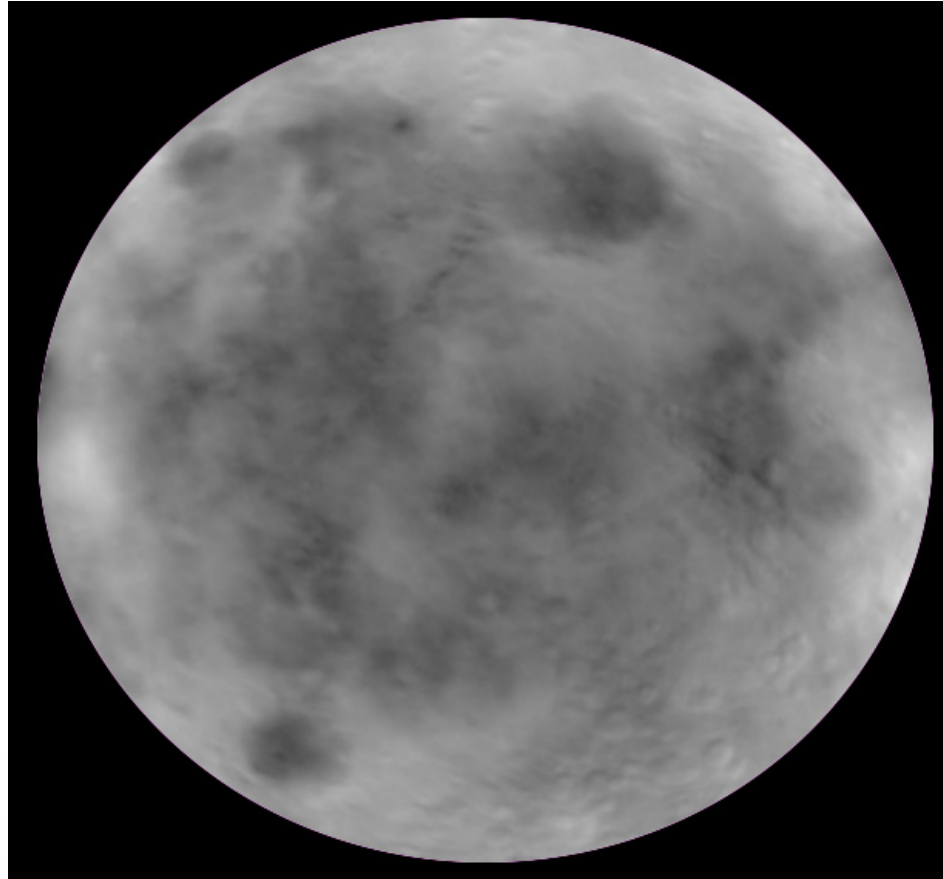


SgB2

MAKO goes to the CSO



- And on poor weather nights...



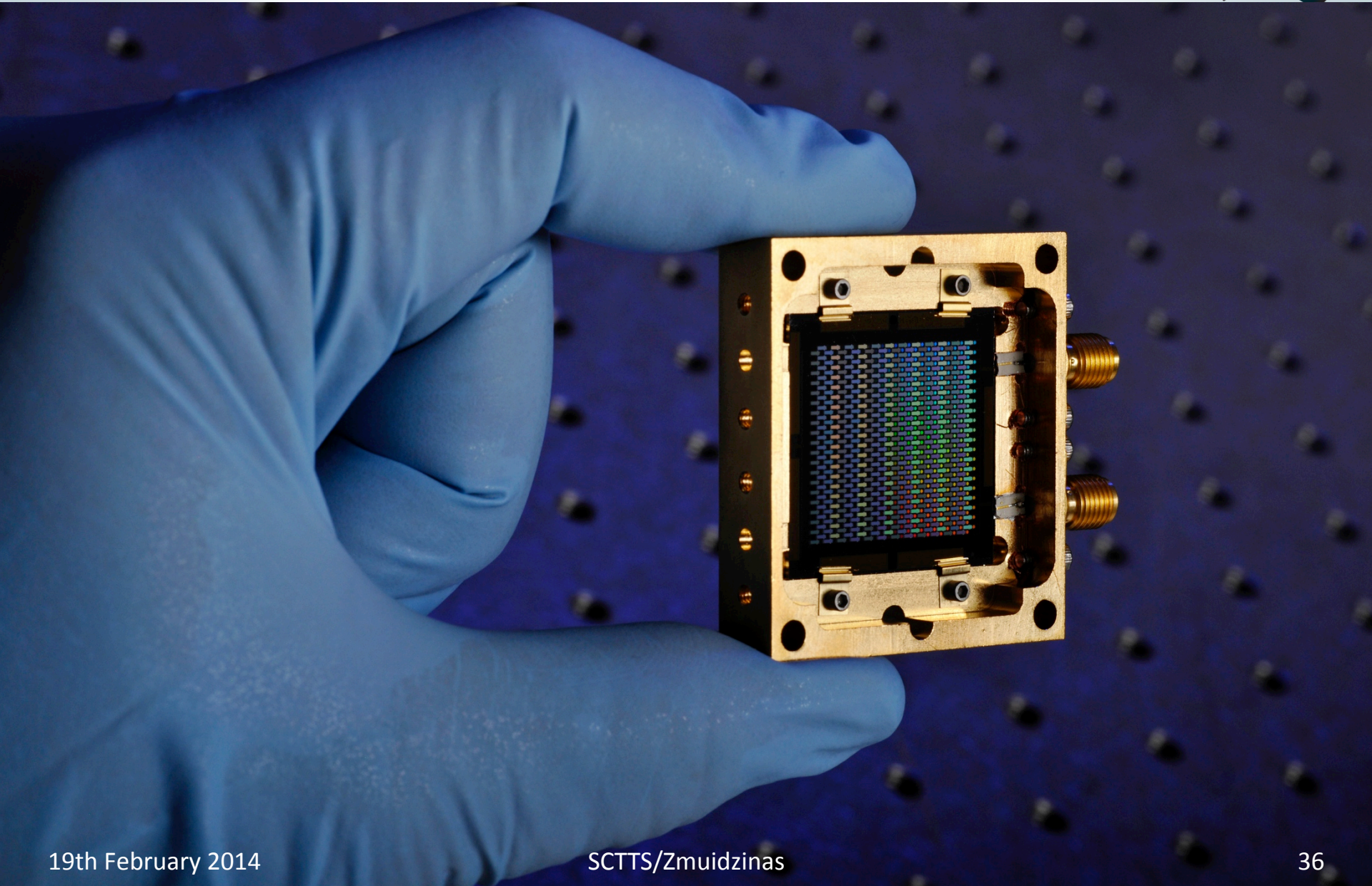
The moon at $\lambda = 350 \mu\text{m}$

Back in the Lab



- MAKO NEFD was $\sim 8x$ that of SHARC-II
 - Was expected to be detector noise limited
 - Recall Sharc-II pixels receive 4.4x more light
- Second-generation arrays (TiN 2G)
 - Lower NEP & NEFD: reach BLIP
 - Increased responsivity (smaller volume \rightarrow microlenses)
 - Reduced capacitor noise (larger area, increased electrode separation)
 - Better uniformity (Tc)

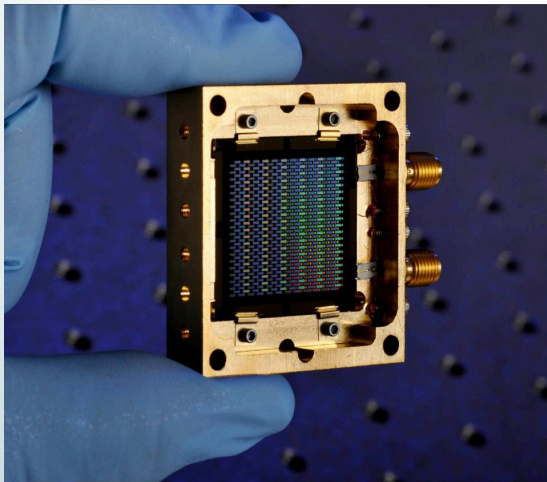
Second-generation 484-pixel TiN array



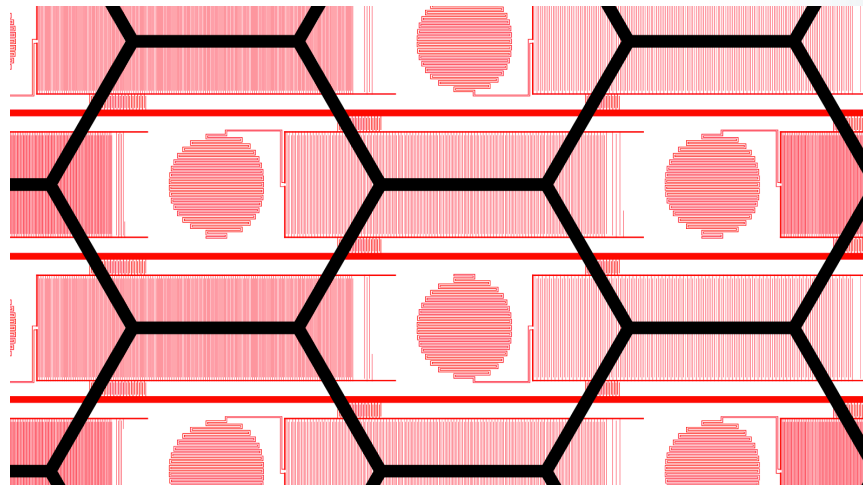
TiN 2G: Hexagonal Packing



- Developed layout to put absorbers on hexagonal lattice while keeping RF readout on rectangular lattice
 - Hexagonal packing is easier to optically couple to than square packing



Packaged hexagonally packed TiN 2G devices



Layout showing inductor, capacitor and coupling (red) + lens positions (black)

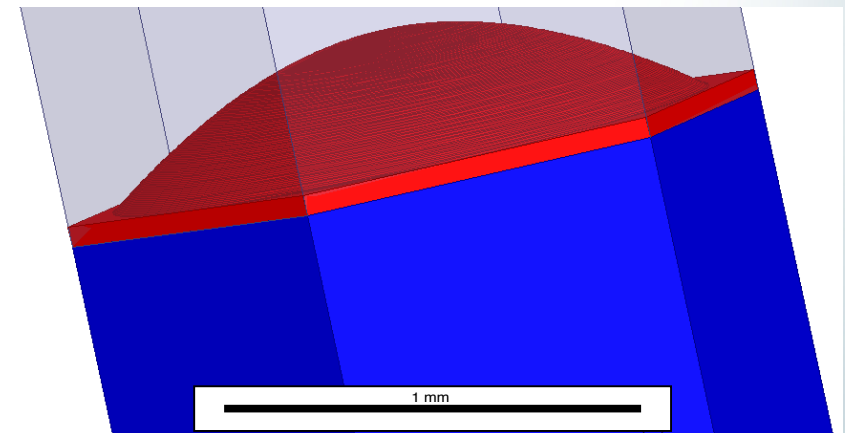
TiN 2G: Improving NEP



- Microlens-coupled arrays offer a number of benefits
 - Smaller inductor volume -> increased responsivity
 - Larger capacitor area -> reduced noise
 - Equal capacitor and inductor areas minimizes readout frequency for fixed total pixel area



Laser etched square packed lens array

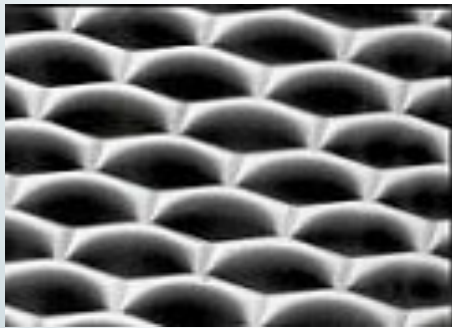


HFSS microlens schematic

Microlens Array Options



- Demonstrated several fabrication methods:
 - Laser etching (Commercial, few \$/lens)
 - Photoresist defining and etching
 - In Development - JPL
 - Gradient Lenses (Caltech/JPL ~ \$0.20/lens)



Laser etch lens
(Veld Laser)

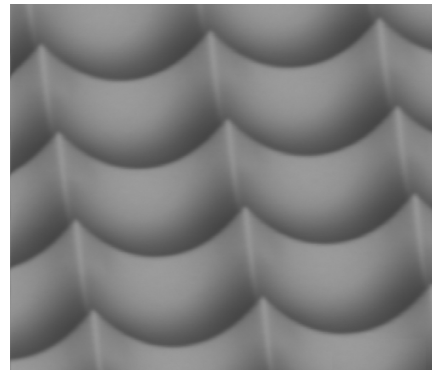
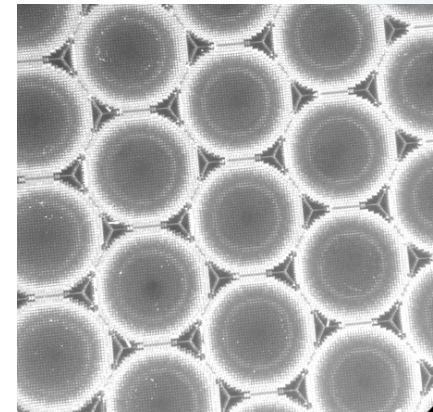


Photo-resist etch
(C. Lee, JPL)



Gradient Lenses
(Caltech/JPL)

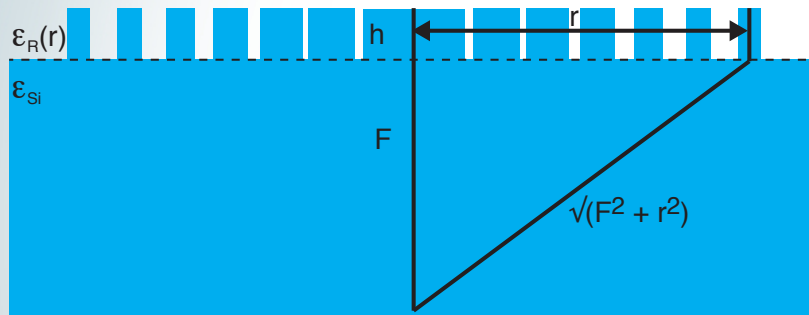
Photos of fabricated microlens arrays

Gradient Index (GRIN) Microlens



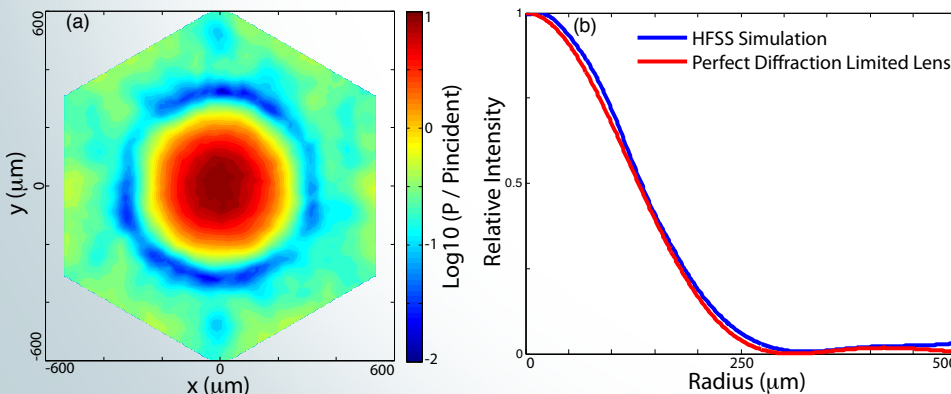
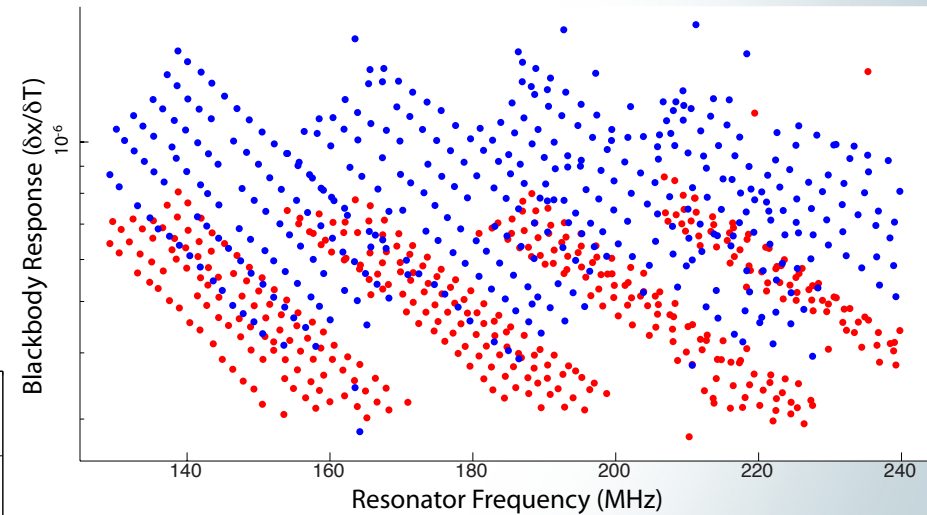
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- Potential low cost lens solution in development at Caltech/JPL
- Made by etching SOI surface to create a gradient in surface index and equal optical path length to focus

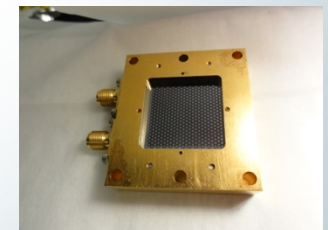
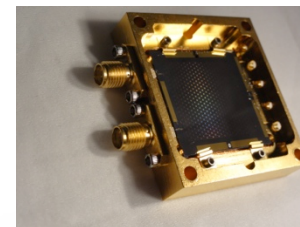


Schematic of etched SOI wafer

Initial lab measurements - GRIN coupled
Unlensed and **Lensed**



HFSS Simulations of GRIN Microlens

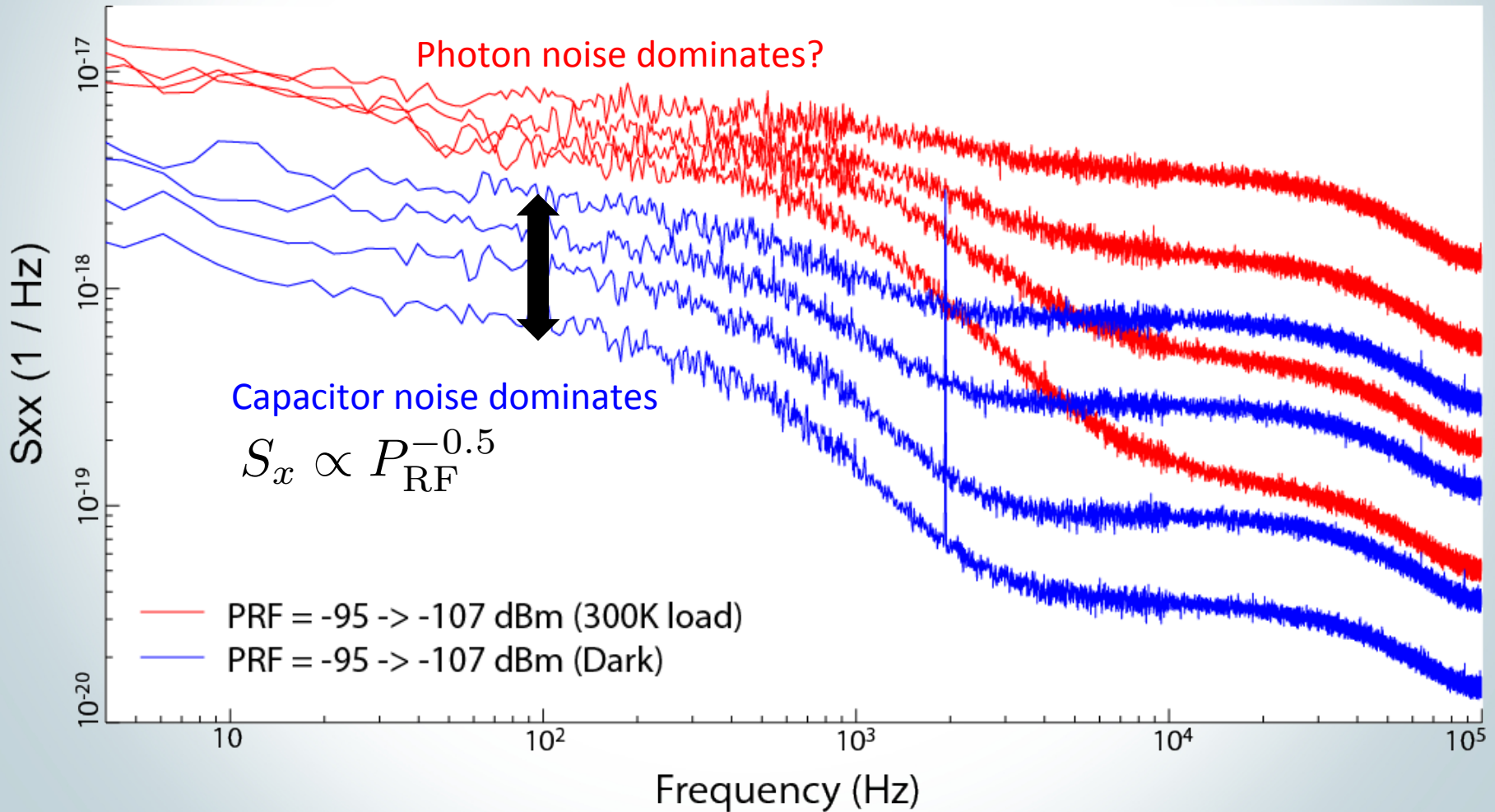


Packaged TiN 2G Test Device

TiN 2G: Initial Lab Results



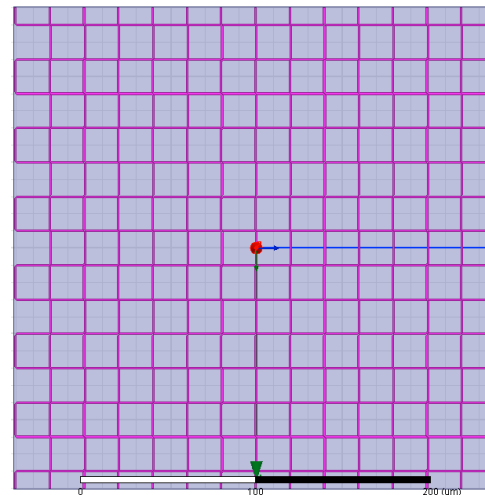
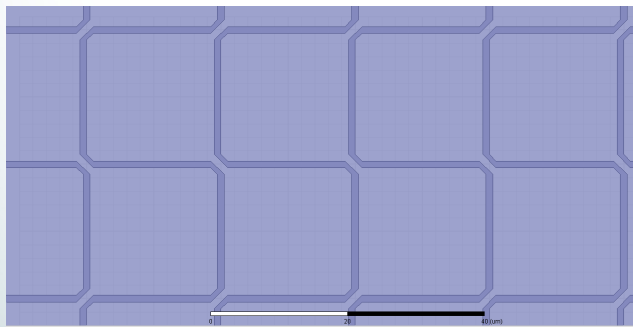
- 300 K blackbody vs Dark
 - noise significantly higher when viewing 300 K blackbody



TiN 3G: Dual Pol Design



- Device layout similar to 2G
- Capacitor fingers spread out more
 - Reduce capacitor noise
- Dual polarization layout
 - HFSS simulations show $>95\%$ absorption in both polarizations



Schematic of a dual polarization sensitive layout

Array Design Details



Ver	Layout	Opt. Couple	Inductor				Capacitor		Freq	Lith Steps	Pixels	Pol.
			Area	Trace	Sep	t	Area	Sep				
			mm ²	μm	μm	nm	mm ²	μm	MHz			
1G	Square	Bare	0.64	4	8	50	<0.4	2	170-240	3	432	1
2G	Hex 1mm ²	μLens (F/2)	0.3	2	4	50	0.6	2-6	200-240	2	488	1
3G	Hex 1mm ²	μLens (F/2)	0.3	1	9	100	0.6	4-9	100-150	2	488	2

- 1G: Tested at CSO (MAKO)
- 2G: Currently lab testing
- 3G: Design phase

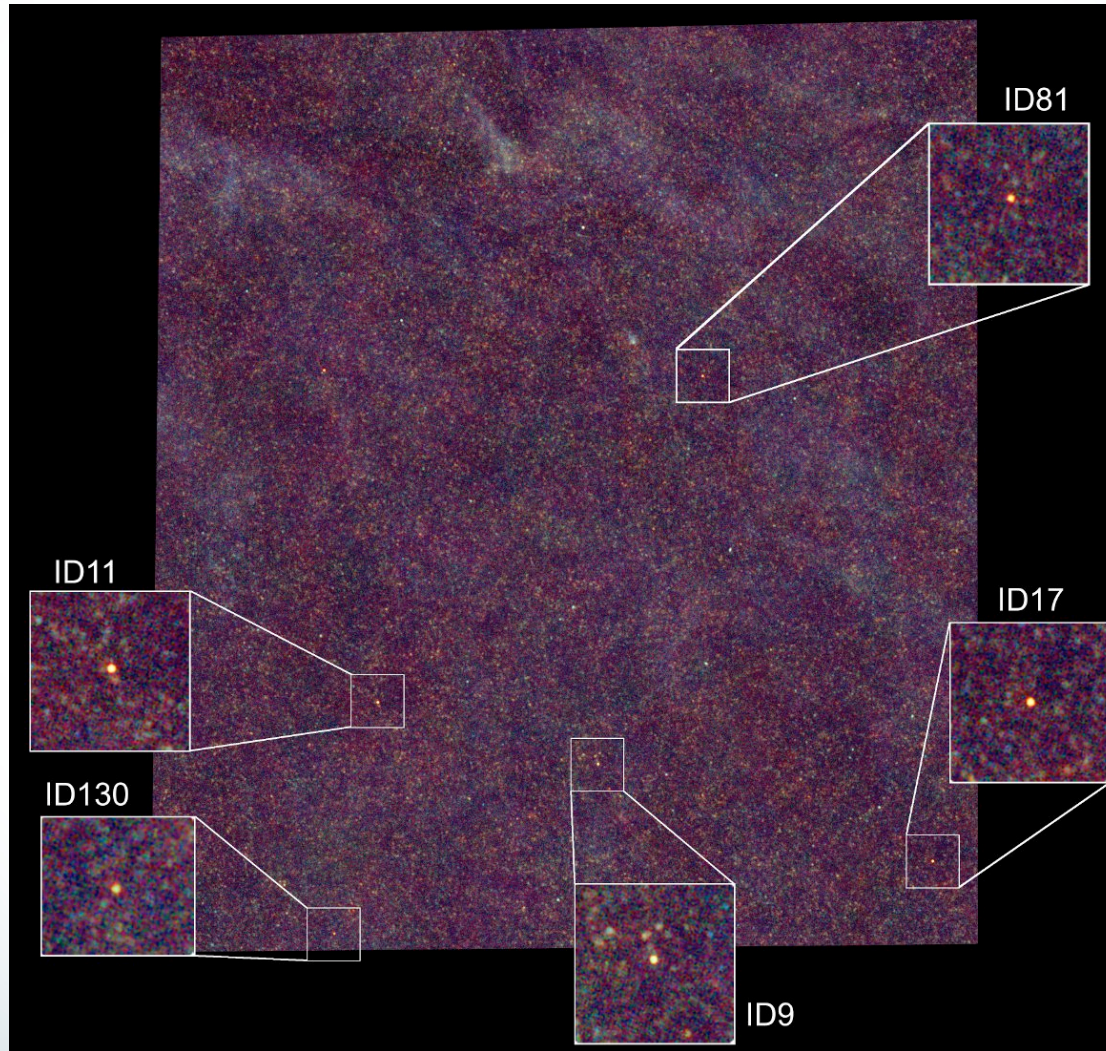
Summary



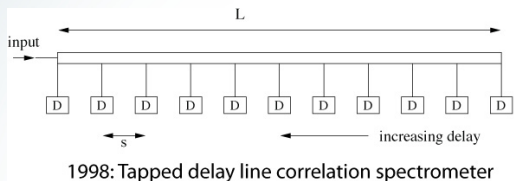
- On-sky, full system demonstration of absorber-coupled TiN MKID array
 - > 400 pixels demonstrated on sky
 - Existing FPGA firmware capable of 4k pixels / ROACH
- On-sky NEFD consistent with lab results
 - Reasonable understanding of TiN / pixel design
 - Lens-coupled devices are approaching BLIP
 - Dual-polarization pixel design under way
- Second MAKO/CSO run being planned for spring 2014

- MAKO collaboration: L. Swenson, C. D. Dowell, A. Kovacs, R. Monroe, M. Hollister, H. G. Leduc, J. Zmuidzinas

How do we get a 3D view of the submm sky ?



Evolution of the Z-spec concept



Thermal noise and correlations in photon detection

1 September 2003 / Vol. 42, No. 25 / APPLIED OPTICS 4989

Jonas Zmuidzinas

CALIFORNIA INSTITUTE OF TECHNOLOGY

Division of Physics, Mathematics, and Astronomy

PROPOSAL TO
YALE UNIVERSITY

For

Development of Superconducting Planar Filterbanks

A subcontract of the proposal entitled:

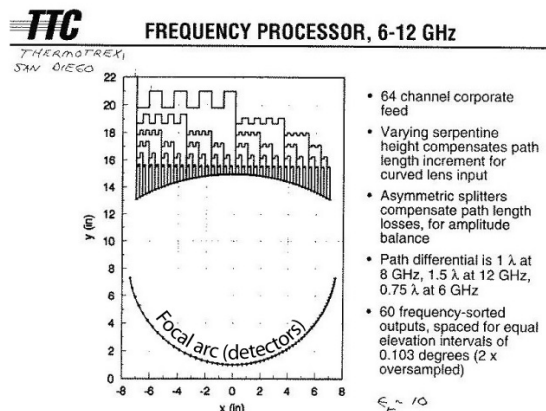
Photon-counting direct detector arrays for submillimeter imaging and spectroscopy

Submitted by Yale University to NASA (99-OSS-01-SPA)

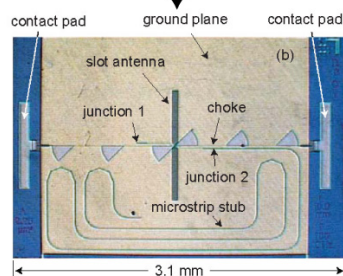
Prof. R. Schoelkopf, Principal Investigator

1 October 1999 - 30 September 2002

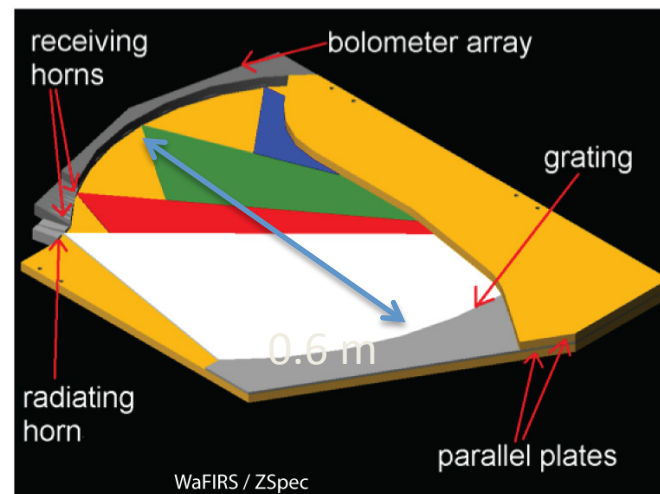
1999: proposal with R. Schoelkopf

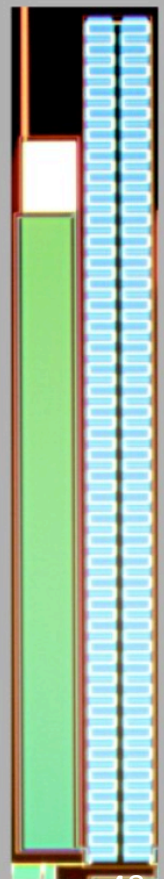
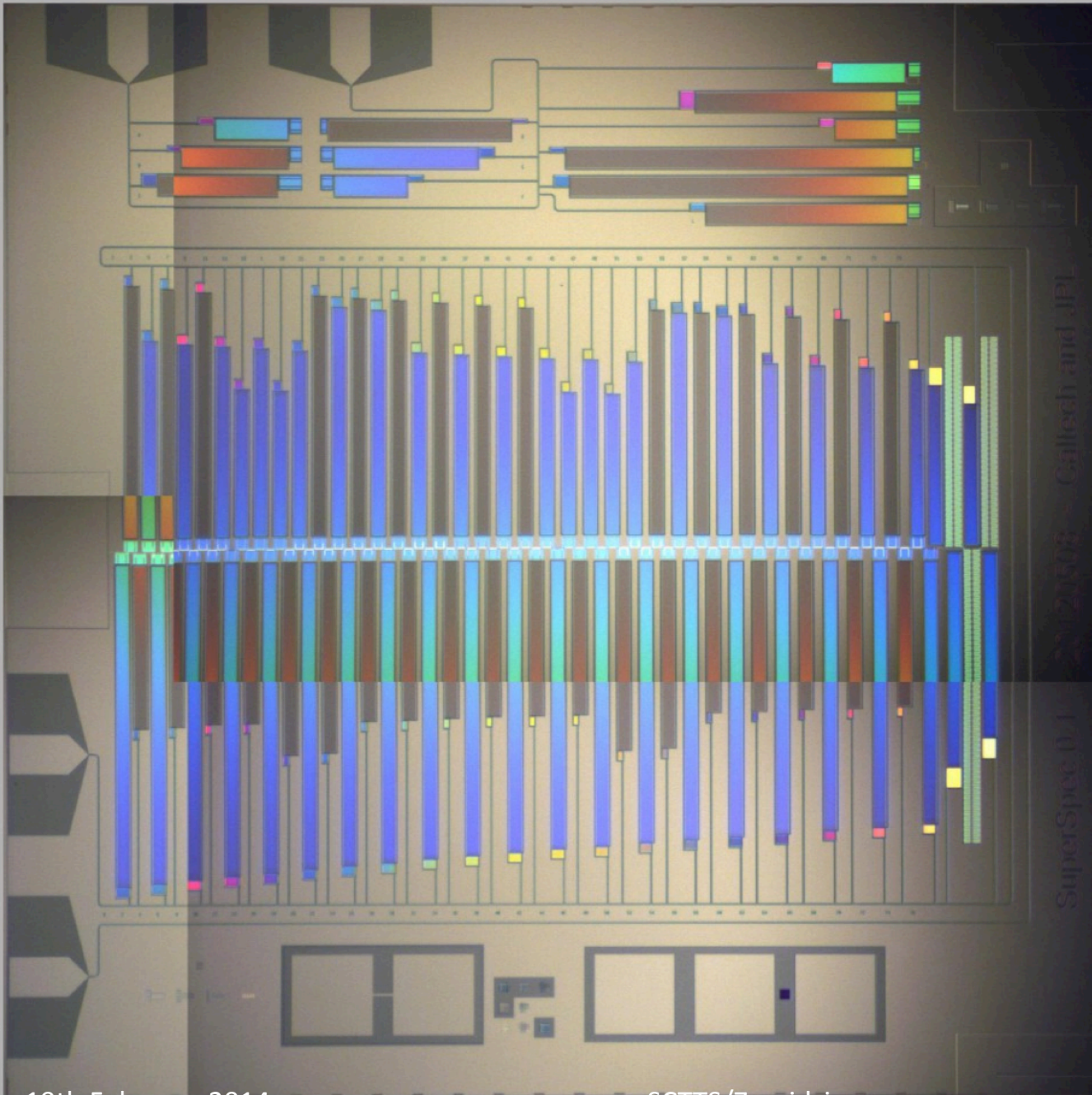


"Pizza" spectrometer: John Lovberg (Sandy Weinreb)
Based on 1971 patent
Superconducting mm-wave version? (GSFC μ SPEC)

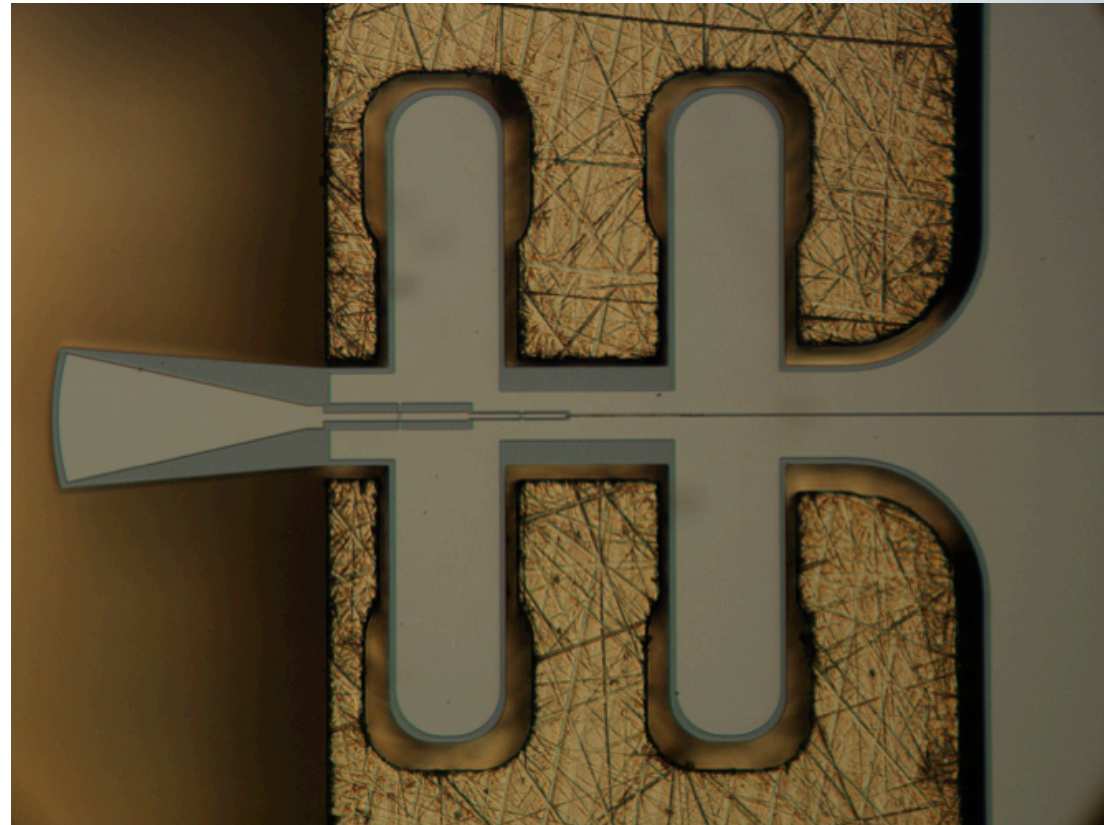
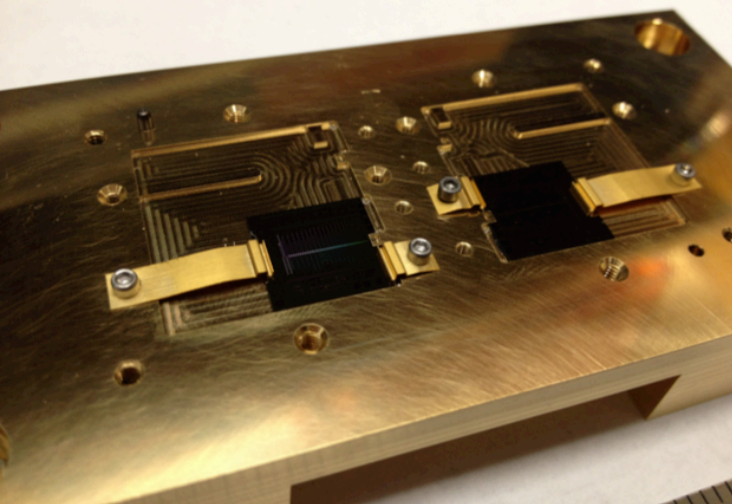
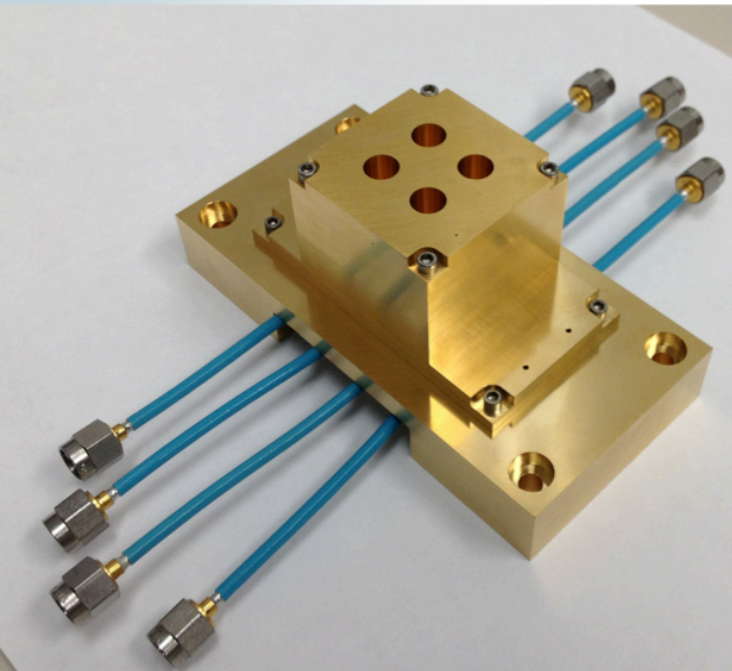


1999: Superconducting microstrip loss test chip





Superconducting spectrometer



Bibliography



- Zmuidzinas J. “Superconducting Microresonators: Physics and Applications”, Annu. Rev. Condens. Matter Phys. 2012 **3**:169-214 (2012)
- Barends R., et al. “Quasiparticle Relaxation in Optically Excited High-Q Superconducting Resonators”, Phys. Rev. Lett. **100**:257002 (2008)
- Doyle S, et al. “Lumped element Kinetic Inductance Detectors”, J. Low Temp. Phys. **151** 530-36 (2008)
- Noroozian O, et al., “Crosstalk Reduction for Superconducting Microwave Resonator Arrays”, IEEE Trans. Micr. Theory Tech. **60** 1235-1243 (2012)
- Swenson L., et al. “Operation of a titanium nitride superconducting microresonator detector in the nonlinear regime”, J. Appl Phys. **113** 104501 (2013)
- McKenney C, et al. “Design considerations for a background limited 350 micron pixel array using lumped element superconducting microresonators”, Proc. of SPIE **8452** 84520S (2012)
- Swenson L, et al. “MAKO: A pathfinder instrument for on-sky demonstration of low cost 350 micron imaging arrays”, Proc. SPIE **8452** (2012)
- Swenson L, et al. “The Status of MAKO”, Proceedings of LTD-15 (2013)
- McKenney C, et al. “Lumped element kinetic inductance detectors: Pixel design for large scale far infrared arrays”, Proceedings of LTD-15 (2013)



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BACKUP SLIDES

SHARC-II Optics



SHARC II: a Caltech Submillimeter Observatory facility camera with 384 pixels

C. Darren Dowell^a, Christine A. Allen^b, Sachidananda Babu^b, Minoru M. Freund^b,
 Matthew B. Gardner^a, Jeffrey Groseth^a, Murzy Jhabvala^b, Attila Kovacs^a,
 Dariusz C. Lis^a, S. Harvey Moseley, Jr.^b, Thomas G. Phillips^a, Robert Silverberg^b,
 George Voellmer^b, and Hiroshige Yoshida^c

^aCalifornia Institute of Technology, Mail Code 320-47, 1200 E. California, Pasadena, CA 91125

^bNASA-Goddard Space Flight Center, Greenbelt, MD 20771

^cCaltech Submillimeter Observatory, 111 Nowelo St., Hilo, HI 96720

Table 2. Summary of SHARC II Optics.

Parameter/Item	Value/Composition
f/ ratio	f/4.5
pixel size	4.6'' × 4.6''
field of view	2.3 square arcminutes
angular resolution, 350 μm	9'' FWHM
mean Strehl ratio, 350 μm	0.95
window	1 mm high-density polyethylene
77 K filter	z-cut crystal quartz, 2 mm front surface: 58 μm clear polyethylene back surface: 50 μm black poly, 8 μm clear poly
4 K filters	quartz (same specifications) 33 cm ⁻¹ lowpass (Cochise Instruments/P. Ade)
4 K bandpass filters (Cochise Instruments/P. Ade)	350 μm, Δλ(FWHM)/λ = 0.13 450 μm, Δλ(FWHM)/λ = 0.10 850 μm, Δλ(FWHM)/λ = 0.08

MAKO Optics

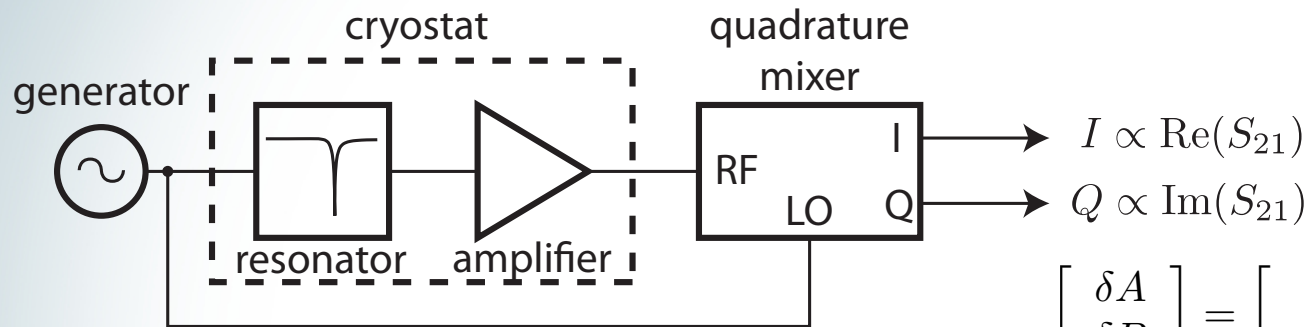


Optics designed to match SHARC-II as much as possible

Parameter/Item	Value/Composition
f/ratio	f/4.5
pixel size (geometric)	0.8 μm x 1.4 μm (0.8 μm x 0.8 μm absorber)
pixel size (on sky)	3.59'' x 6.57'' (3.59'' x ~3.59'' absorber)
filling factor	57%
rows x columns (# pixels)	16 x 27 (432)
usable pixels	418 resonances identified, >380 currently used (88-97% yield)
field of view	105'' x 97'' (2.83 square arcminute)
angular resolution, 350 μm	9'' (?)
mean Strehl ratio, 350 μm	0.95 (?)
window	1 mm high-density polyethylene
65 K stage	z-cut crystal quartz, 2 mm front surface: 58 μm clear polyethylene back surface: 50 μm black poly, 8 μm clear poly
4 K	100 μm and 300 μm low-pass filter (QMC)
250-270 mK (on sample holder)	350 μm bandpass, 10% bandwidth (QMC)

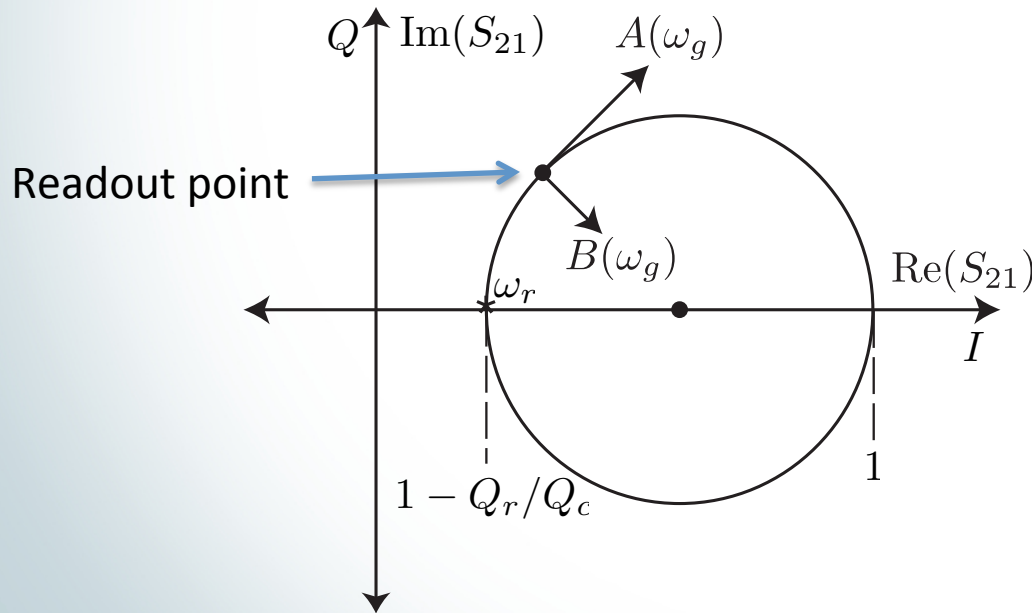
TABLE I: Summary of MAKO optics

Single-channel analog readout



$$\begin{bmatrix} \delta A \\ \delta B \end{bmatrix} = \begin{bmatrix} \cos \theta & \sin \theta \\ -\sin \theta & \cos \theta \end{bmatrix} \begin{bmatrix} \delta I \\ \delta Q \end{bmatrix}$$

$$\begin{aligned} \delta x(t) &\propto \delta A(t) \\ \delta Q_i^{-1}(t) &\propto \delta B(t) \end{aligned}$$



Resonator frequency, Q
monitored at ~ 100 kHz
sampling rate

Response bandwidth set by
quasiparticle lifetime and
resonator ring-down time